



XT25Q64D

Quad IO Serial NOR Flash Datasheet

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Serial NOR Flash Memory

1.8V Multi I/O with 4KB, 32KB & 64KB Sector/Block Erase

■ 64M -bit Serial Flash

- 8192K-byte
- 256 bytes per programmable page

■ Standard, Dual, Quad SPI, DTR

- Standard SPI: SCLK, CS#, SI, SO, WP#, HOLD#/RESET#
- Dual SPI: SCLK, CS#, IOO, IO1, WP#, HOLD#/RESET#
- Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3
- QPI: SCLK, CS#, IO0, IO1, IO2, IO3
- SPI/QPI DTR(Double Transfer Rate) Read

■ Flexible Architecture

- Sector of 4K-bytes
- Block of 32/64k-bytes

Advanced security Features

- 3*1024-Bytes Security Registers With OTP Lock
- Support 128 bits Unique ID

■ Software/Hardware Write Protection

- Write protect all/portion of memory via software
- Enable/Disable protection with WP# Pin
- Top or Bottom, Sector or Block selection

■ Continuous Read With 8/16/32/64-byte Wrap

■ Erase/Program Suspend/Resume

Package Options

- See 1.1 Available Ordering OPN
- All Pb-free packages are compliant RoHS, Halogen-Free and REACH.

■ Temperature Range & Moisture Sensitivity Level

Industrial Level Temperature. (-40 $^{\circ}$ C to +85 $^{\circ}$ C), MSL3

■ Low Power Consumption

• 0.4uA typical Power-Down current

■ Single Power Supply Voltage

• 1.65~2.0V

■ Endurance and Data Retention

- Minimum 100,000 Program/Erase Cycle
- 20-year Data Retention typical

■ High Speed Clock Frequency

- 133MHz for fast read with 30PF load
- Dual I/O Data transfer up to 266Mbits/s
- Quad I/O Data transfer up to 532Mbits/s
- QPI Mode Data transfer up to 432Mbits/s
- DTR Quad I/O Data transfer up to 768Mbits/s

Program/Erase Speed

Page Program time: 0.4ms typical

Sector Erase time: 40ms typical

Block Erase time: 0.12/0.15s typical

• Chip Erase time: 20s typical



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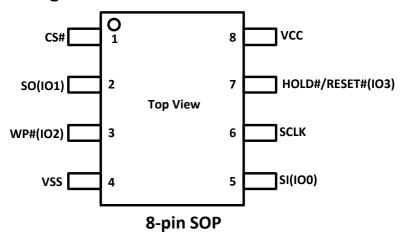
1. GENERAL DESCRIPTION

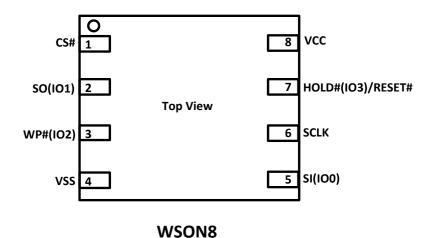
The XT25Q64D (64M-bit) Serial flash supports standard Serial Peripheral Interface (SPI), Dual/Quad SPI: Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2 (WP#), and I/O3 (HOLD#/RESET#).

1.1. Available Ordering OPN

| OPN | Package Type | Package Carrier |
|---------------|--------------|-----------------|
| XT25Q64DSSIGU | SOP8 208mil | Tube |
| XT25Q64DSSIGT | SOP8 208mil | Tape & Reel |
| XT25Q64DWOIGT | WSON8 6x5mm | Tape & Reel |
| XT25Q64DWLIGT | WLCSP-WL | Tape & Reel |
| XT25Q64DLCIGT | WLCSP-LC | Tape & Reel |

1.2. Connection Diagram





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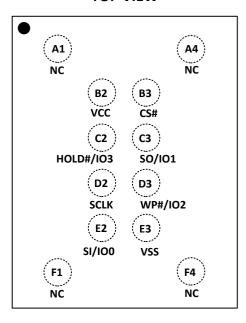
TOP VIEW A1 NC A2 А3 A4 VCC CS# B2) (B3) HOLD#/IO3 SO/IO1 C2 **C3** SCLK WP#/IO2 D1 D2 D3 D4 SI/IO0 VSS

A4 NC А3 A2 CS# vcc в2 В3 SO/IO1 HOLD#/IO3 C2 **C3** WP#/IO2 SCLK D4 D3 D2 D1 SI/I00 vss

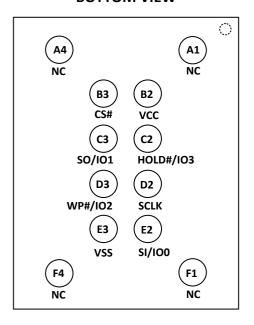
BOTTOM VIEW

WLCSP-WL

TOP VIEW



BOTTOM VIEW



WLCSP-LC



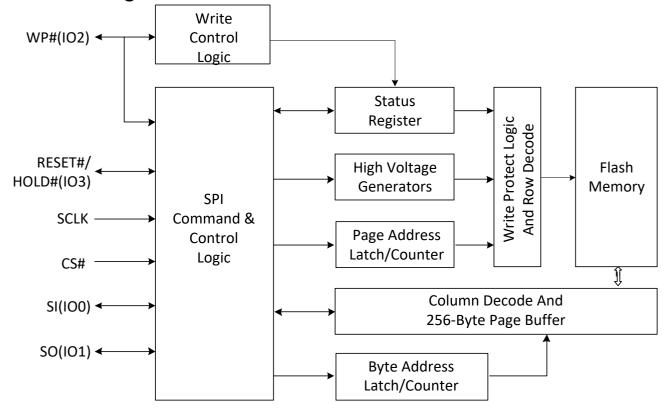
1.3. Pin Description

| Pin Name | I/O | Description |
|--------------------|-----|---|
| CS# | I | Chip Select Input |
| SO (IO1) | I/O | Data Output (Data Input Output 1) |
| WP# (IO2) | I/O | Write Protect Input (Data Input Output 2) |
| VSS | | Ground |
| SI (IO0) | I/O | Data Input (Data Input Output 0) |
| SCLK | I | Serial Clock Input |
| HOLD#/RESET# (IO3) | I/O | Hold or Reset Input (Data Input Output 3) |
| vcc | | Power Supply |

Notes:

- 1. IOO and IO1 are used for Standard and Dual SPI instructions
- 2. IO0 IO3 are used for Quad SPI instructions, WP# & HOLD# (or Reset#) functions are only available for Standard/Dual SPI.

1.4. Block Diagram





1.5. Memory Description

Uniform Block Sector Architecture

| Block(64K-byte) | Block(32K-byte) | Sector(4K-byte) | Addres | ss Range |
|-----------------|-----------------|-----------------|---------|----------|
| | | 2047 | 7FF000H | 7FFFFFH |
| | 255 | | | |
| 427 | | 2040 | 7F8000H | 7F8FFFH |
| 127 | | 2039 | 7F7000H | 7F7FFFH |
| | 254 | | | |
| | | 2032 | 7F0000H | 7F0FFFH |
| | | 2031 | 7EF000H | 7EFFFFH |
| | 253 | | | |
| | | 2024 | 7E8000H | 7E8FFFH |
| 126 | | 2023 | 7E7000H | 7E7FFFH |
| | 252 | | | |
| | | 2016 | 7E0000H | 7E0FFFH |
| | | | | |
| | | | | |
| | | | | |
| | | 31 | 01F000H | 01FFFFH |
| | 3 | | | |
| 4 | | 24 | 018000H | 018FFFH |
| 1 | | 23 | 017000H | 017FFFH |
| | 2 | | | |
| | | 16 | 010000H | 010FFFH |
| | | 15 | 00F000H | 00FFFFH |
| | 1 | | | |
| 0 | | 8 | 008000Н | 008FFFH |
| U | | 7 | 007000H | 007FFFH |
| | 0 | | | |
| | | 0 | 000000Н | 000FFFH |



2. DEVICE OPERATION

2.1. SPI Mode

Standard SPI

The device features a serial peripheral interface on 4 signals bus: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and data shifts out on the falling edge of SCLK.

Dual SPI

The device supports Dual SPI operation when using the "Dual Output Fast Read" and "Dual I/O Fast Read" (3BH and BBH) commands. These commands allow data to be transferred to or from the device at two times the rate of the standard SPI. When using the Dual SPI command the SI and SO pins become bidirectional I/O pins: IOO and IO1.

Quad SPI

The device supports Quad SPI operation when using the "Quad Output Fast Read"," Quad I/O Fast Read","DTR Fast Read Quad I/O" (6BH, EBH, EDH) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI command the SI and SO pins become bidirectional I/O pins: IOO and IO1, and WP# and HOLD# pins become IO2 and IO3. Quad SPI commands require the non-volatile Quad Enable bit (QE) in Status Register to be set.

2.2. QPI Mode

The device supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Dual/Quad SPI mode to QPI mode using the "Enable the QPI (38H)" command. The QPI mode utilizes all four IO pins to input the command code. Standard/Dual/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given times. "Enable the QPI (38H)" and "Disable the QPI (FFH)" commands are used to switch between these two modes. Upon power-up and after software reset using "Enable Chip Reset (66H)" and "Reset (99H)" command, the default state of the device is Standard/Dual/Quad SPI mode. The QPI mode requires the non-volatile Quad Enable bit (QE) in Status Register to be set.

2.3. DTR Read

To effectively improve the read operation throughput without increasing the serial clock frequency, the device introduces multiple DTR (Double Transfer Rate) Read instructions that support Standard/Dual/Quad SPI and QPI modes. The byte-long instruction code is still latched into the device on the rising edge of the serial clock similar to all other SPI/QPI instructions. Once a DTR instruction code is accepted by the device, the address input and data output will be latched on both rising and falling edges of the serial clock.

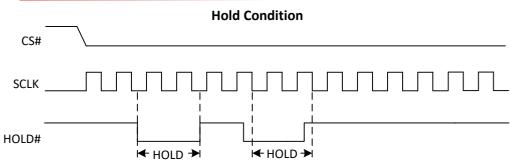
2.4. Hold Function

The HOLD# signal goes low to stop any serial communications with the device, but doesn't stop the operation of write status register, programming, or erasing in progress.

The operation of HOLD, need CS# keep low, and starts on falling edge of the HOLD# signal, with SCLK signal being low (if SCLK is not being low, HOLD operation will not start until SCLK being low). The HOLD condition ends on rising edge of HOLD# signal with SCLK being low (If SCLK is not being low, HOLD operation will not end until SCLK being low).

The SO is high impedance, both SI and SCLK don't care during the HOLD operation, if CS# drives high during HOLD operation, it will reset the internal logic of the device. To re-start communication with chip, the HOLD# must be at high and then CS# must be at low.



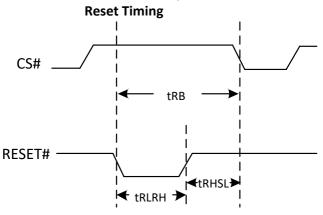


2.5. RESET Function

The RESET# pin allows the device to be reset by the control. The pin 7 can be configured as a RESET# pin depending on the status register setting, which need QE=0 and HOLD/RST=1.

The RESET# pin goes low for a period of tRLRH or longer will reset the flash. After reset cycle, the flash is at the following states:

- Standby mode.
- All the volatile bits will return to the default status as power on.



| Symbol | Parameter | Min | Тур | Max | Unit. |
|--------|-----------------------------|-----|-----|-----|-------|
| tRLRH | Reset Pulse Width | 1 | | | us |
| tRHSL | Reset High Time Before Read | 200 | | | us |
| tRB | Reset Recovery Time | | | 1 | ms |



2.6. The Reset Signaling Protocol (JEDEC 252)

The protocol consists of two phases: reset request, and completion (a device internal reset).

Reset Request

- 1. CS# is driven active low to select the SPI slave (Note1)
- 2. Clock (SCK) remains stable in either a high or low state (Note 2)
- 3. SI / IOO is driven low by the bus master, simultaneously with CS# going active low, (Note 3)
- 4. CS# is driven inactive (Note 4).

Repeat the steps 1-4 each time alternating the state of SI (Note 5).

NOTE 1 This powers up the SPI slave.

NOTE 2 This prevents any confusion with a command, as no command bits are transferred (clocked).

NOTE 3 No SPI bus slave drives SI during CS# low before a transition of SCK, i.e., slave streaming output active is not allowed until after the first edge of SCK.

1.8V Quad IO Serial Flash

NOTE 4 The slave captures the state of SI on the rising edge of CS#.

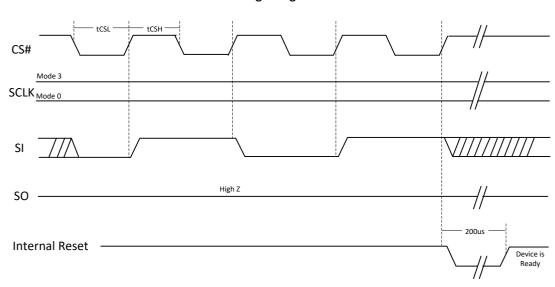
NOTE 5 SI is low on the first CS#, high on the second, low on the third, high on the fourth (This provides a 5h pattern, to differentiate it from random noise).

Reset Completion

After the fourth CS# pulse, the slave triggers its internal reset.

Timing Diagram and Timing Parameters

Reset Signaling Protocol





3. STATUS REGISTER

Status Register-1

| S7 | S6 | S5 | S4 | S3 | S2 | S1 | S0 |
|--|--------------|----------------------|----------------------|----------------------|----------------------|------------------------|----------------------------|
| SRP0 | BP4 | BP3 | BP2 | BP1 | BP0 | WEL | WIP |
| Status Regis- ter Protection Bit | | Block Protect Bit | Block Protect Bit | Block Protect Bit | Block Protect Bit | Write Enable Latch | Erase/Write In Progress |
| Non-volatile | Non-volatile | Non-volatile | Non-volatile | Non-volatile | Non-volatile | Volatile, Read Only | Volatile, Read Only |

Status Register-2

| S15 | S14 | S13 | S12 | S11 | S10 | S9 | \$8 |
|------------------------|---------------------------|--------------------------------|--------------------------------|--------------------------------|------------------------|--------------|--|
| SUS1 | CMP | LB3 | LB2 | LB1 | SUS2 | QE | SRP1 |
| Erase Suspend | Complement Protect Bit | | | Security Register Lock Bit | Program Sus- pend | Quad Enable | Status Regis- ter Protection Bit |
| Volatile, Read Only | Non-volatile | Non-volatile writable (OTP) | Non-volatile writable (OTP) | Non-volatile writable (OTP) | Volatile, Read Only | Non-volatile | Non-volatile |

Status Register-3

| S23 | S22 | S21 | S20 | S19 | S18 | S17 | S16 |
|-------------------------------|--------------|---------------------------|----------|------------|----------------------------|--------------------------|------------|
| Hold/RST | DRV1 | DRV0 | Reserved | Reserved | WPS | LC1 | Reserved |
| HOLD# or Re- set# Function | • | Output Driver Strength | Reserved | Reserved | Write protection selection | Latency Code | Reserved |
| Non-volatile | Non-volatile | Non-volatile | Reserved | Reserved | Non-volatile | Non-volatile writable | Reserved |

HOLD/RST

The HOLD/RST bit is used to determine whether HOLD# or RESET# function should be implemented on the hardware pin for 8-pin packages. When HOLD/RST=0, the pin acts as HOLD#, When the HOLD/RST=1, the pin acts as RESET#. However, the HOLD# or RESET# function are only available when QE=0, If QE=1, The HOLD# and RESET# functions are disabled, the pin acts as dedicated data I/O pin.

DRV1, DRV0

The Output Driver Strength (DRV1 & DRV0) bits are used to determine the output driver strength for the Read operations.

| DRV1 | DRV0 | Driver Strength |
|------|------|-----------------|
| 0 | 0 | 25% |
| 0 | 1 | 50% |
| 1 | 0 | 75% (default) |
| 1 | 1 | 100% |

WPS

The WPS Bit is used to select which Write Protect scheme should be used. When WPS=0, the device will use the combination of CMP, BP (4:0) bits to protect a specific area of the memory array. When WPS=1, the device will utilize the Individual Block Locks to protect any individual sector or blocks. The default value for all Individual Block Lock bits is 1 upon device power on or after reset.



10

The Latency Code (LC) selects the mode and number of dummy cycles between the end of address and the start of read data output for command EDH under SPI/QPI modes and command 0EH under QPI mode.

Some read commands send mode bits following the address to indicate that the next command will be of the same type with an implied, rather than an explicit instruction. The next command thus does not provide an instruction Byte, only a new address and mode bits. This reduces the time needed to send each command when the same command type is repeated in a sequence of commands.

Dummy cycles provide additional latency that is needed to complete the initial read access of the flash array before data can be returned to the host system. Some read commands require additional latency cycles as the SCLK frequency is increased.

| Latency Cod | de and | l DTR | Mode | Frequ | uency | Table |
|-------------|--------|-------|------|-------|-------|-------|
|-------------|--------|-------|------|-------|-------|-------|

| LC | Quad IO DTR Read EDH | DTR Burst Read With Wrap 0EH | Read Clock Frequency (MHz) |
|----|-------------------------|------------------------------------|-------------------------------|
| 0 | 8 (Default) | 8 (Default) | 96 |
| 1 | 6 | 6 | 72 |

SUS1, SUS2

The SUS1 and SUS2 bits are read only bits in the status register (S15 and S10) that are set to 1 after executing an Program/Erase Suspend (75H) command (The Erase Suspend will set the SUS1 to 1, and the Program Suspend will set the SUS2 to 1). The SUS1 and SUS2 bits are cleared to 0 by Program/Erase Resume (7AH) command, software reset (66H+99H) command as well as a power-down, power-up cycle.

CMP

The CMP bit is a non-volatile Read/Write bit in the Status Register (S14). It is used in conjunction the BP4-BP0 bits to provide more flexibility for the array protection. Please see the Status register Memory Protection table for details. The default setting is CMP=0.

LB1, LB2, LB3

The LB1, LB12, LB3 bits are non-volatile One Time Program (OTP) bits in Status Register (S11-S13) that provide the write protect control and status to the Security Registers. The default state of LB1-LB3 are 0, the security registers are unlocked. The LB1-LB3 bits can be set to 1 individually using the Write Register instruction. The LB1-LB3 bits are One Time Programmable, once its set to 1, the Security Registers will become read-only permanently.

QE

The Quad Enable (QE) bit is a non-volatile Read/Write bit in the Status Register that allows Quad operation. When the QE bit is set to 0 (Default) the WP# pin and HOLD# pin are enable. When the QE pin is set to 1, the Quad IO2 and IO3 pins are enabled. (The QE bit should never be set to 1 during standard SPI or Dual SPI operation if the WP# or HOLD# pins are tied directly to the power supply or ground).



SRP1, SRP0

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the type of write protection: software protection, hardware protection, power supply lockdown or one-time programmable protection.

| own or one time programmable protection | | | | | | | |
|---|------|-----|----------------------------|---|--|--|--|
| SRP1 | SRP0 | WP# | Status Register | Description | | | |
| 0 | 0 | Х | Software Protected | The Status Register can be written to after a Write Enable command, WEL=1. (Default) | | | |
| 0 | 1 | 0 | Hardware Protected | WP#=0, the Status Register locked and cannot be written to. | | | |
| 0 | 1 | 1 | Hardware Unprotected | WP#=1, the Status Register is unlocked and can be written to after a Write Enable command, WEL=1. | | | |
| 1 | 0 | Х | Power Supply Lock- Down | Status Register is protected and cannot be written to again until the next Power-Down, Power-Up cycle. Note 1 | | | |
| 1 | 1 | х | One-Time Program Note 2 | Status Register is protected and cannot be written to. | | | |

NOTE:

- 1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.
- 2. This feature is available on special order. Please contact XTX for details.

BP4, BP3, BP2, BP1, BP0

The Block Protect (BP4, BP3, BP2, BP1, BP0) bits are non-volatile. They define the size of the area to be software protected against Program and Erase commands. These bits are written with the Write Status Register (WRSR) command. When the Block Protect (BP4, BP3, BP2, BP1, BP0) bits are set to 1, the relevant memory area (as defined in Table1)becomes protected against Page Program (PP), Sector Erase (SE) and Block Erase (BE) commands. The Block Protect(BP4, BP3, BP2, BP1, BP0) bits can be written provided that the Hardware Protected mode has not been set. The Chip Erase (CE) command is executed if the Block Protect (BP2, BP1, BP0) bits are 0 and CMP=0 or the Block Protect (BP2, BP1, BP0) bits are 1 and CMP=1.

WEL

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write Status Register, Program or Erase command is accepted.

WIP

The Write In Progress (WIP) bit indicates whether the memory is busy in program/erase/write status register progress. When WIP bit sets to 1, means the device is busy in program/erase/write status register progress, when WIP bit sets 0, means the device is not in program/erase/write status register progress.



4. DATA PROTECTION

The device provide the following data protection methods:

- Write Enable (WREN) command: The WREN command sets the Write Enable Latch bit (WEL). The WEL bit will return to reset by the following situation:
 - Power-Up / Software Reset (66H+99H)
 - Write Disable (WRDI)
 - Write Status Register (WRSR)
 - Page Program (PP)
 - Sector Erase (SE) / Block Erase (BE) / Chip Erase (CE)
 - Erase Security Register / Program Security Register
- Software Protection Mode: The Block Protect (BP4, BP3, BP2, BP1, BP0) bits, WPS bit and CMP bit define the section of the memory array that can be read but cannot be changed.
- Hardware Protection Mode: WP# goes low to prevent writing status register.
- Deep Power-Down Mode: In Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down Mode command (ABH) and software reset (66H+99H).

Table 1.0 XT25Q64D Protected area size (WPS=0, CMP=0)

| | Status I | Register | Conter | nt | | Memory Conte | nt | |
|-----|----------|----------|--------|-----|------------|-----------------|---------|--------------|
| BP4 | BP3 | BP2 | BP1 | BP0 | Blocks | Addresses | Density | Portion |
| Х | Х | 0 | 0 | 0 | NONE | NONE | NONE | NONE |
| 0 | 0 | 0 | 0 | 1 | 126 to 127 | 7E0000H-7FFFFFH | 128KB | Upper 1/64 |
| 0 | 0 | 0 | 1 | 0 | 124 to 127 | 7C0000H-7FFFFFH | 256KB | Upper 1/32 |
| 0 | 0 | 0 | 1 | 1 | 120 to 127 | 780000H-7FFFFFH | 512KB | Upper 1/16 |
| 0 | 0 | 1 | 0 | 0 | 112 to 127 | 700000H-7FFFFFH | 1MB | Upper 1/8 |
| 0 | 0 | 1 | 0 | 1 | 96 to 127 | 600000H-7FFFFFH | 2MB | Upper 1/4 |
| 0 | 0 | 1 | 1 | 0 | 64 to 127 | 400000H-7FFFFFH | 4MB | Upper 1/2 |
| 0 | 1 | 0 | 0 | 1 | 0 to 1 | 000000H-01FFFFH | 128KB | Lower 1/64 |
| 0 | 1 | 0 | 1 | 0 | 0 to 3 | 000000H-03FFFFH | 256KB | Lower 1/32 |
| 0 | 1 | 0 | 1 | 1 | 0 to 7 | 000000H-07FFFFH | 512KB | Lower 1/16 |
| 0 | 1 | 1 | 0 | 0 | 0 to 15 | 000000H-0FFFFFH | 1MB | Lower 1/8 |
| 0 | 1 | 1 | 0 | 1 | 0 to 31 | 000000H-1FFFFFH | 2MB | Lower 1/4 |
| 0 | 1 | 1 | 1 | 0 | 0 to 63 | 000000H-3FFFFFH | 4MB | Lower 1/2 |
| Х | Х | 1 | 1 | 1 | 0 to 127 | 000000H-7FFFFH | 8MB | ALL |
| 1 | 0 | 0 | 0 | 1 | 127 | 7FF000H-7FFFFFH | 4KB | Top Block |
| 1 | 0 | 0 | 1 | 0 | 127 | 7FE000H-7FFFFFH | 8KB | Top Block |
| 1 | 0 | 0 | 1 | 1 | 127 | 7FC000H-7FFFFFH | 16KB | Top Block |
| 1 | 0 | 1 | 0 | Х | 127 | 7F8000H-7FFFFFH | 32KB | Top Block |
| 1 | 0 | 1 | 1 | 0 | 127 | 7F8000H-7FFFFFH | 32KB | Top Block |
| 1 | 1 | 0 | 0 | 1 | 0 | 000000H-000FFFH | 4KB | Bottom Block |
| 1 | 1 | 0 | 1 | 0 | 0 | 000000H-001FFFH | 8KB | Bottom Block |
| 1 | 1 | 0 | 1 | 1 | 0 | 000000H-003FFFH | 16KB | Bottom Block |



| 1 | 1 | 1 | 0 | Х | 0 | 000000H-007FFFH | 32KB | Bottom Block |
|---|---|---|---|---|---|-----------------|------|--------------|
| 1 | 1 | 1 | 1 | 0 | 0 | 000000H-007FFFH | 32KB | Bottom Block |

Table1.1 XT25Q64D Protected area size (WPS=0, CMP=1)

| ; | Status R | egister | Conten | | | Protected area size (WPS=0, CMPS Memory Conte | • | |
|-----|----------|---------|--------|-----|-----------|--|---------|-------------|
| BP4 | BP3 | BP2 | BP1 | BP0 | Blocks | Addresses | Density | Portion |
| Х | Х | 0 | 0 | 0 | ALL | 000000H-7FFFFH | ALL | ALL |
| 0 | 0 | 0 | 0 | 1 | 0 to 125 | 000000H-7DFFFFH | 8064KB | Lower 63/64 |
| 0 | 0 | 0 | 1 | 0 | 0 to 123 | 000000H-7BFFFFH | 7936KB | Lower 31/32 |
| 0 | 0 | 0 | 1 | 1 | 0 to 119 | 000000H-77FFFFH | 7680KB | Lower 15/16 |
| 0 | 0 | 1 | 0 | 0 | 0 to 111 | 000000H-6FFFFFH | 7MB | Lower 7/8 |
| 0 | 0 | 1 | 0 | 1 | 0 to 95 | 000000H-5FFFFFH | 6MB | Lower 3/4 |
| 0 | 0 | 1 | 1 | 0 | 0 to 63 | 000000H-3FFFFFH | 4MB | Lower 1/2 |
| 0 | 1 | 0 | 0 | 1 | 2 to 127 | 020000H-7FFFFFH | 8064KB | Upper 63/64 |
| 0 | 1 | 0 | 1 | 0 | 4 to 127 | 040000H-7FFFFFH | 7936KB | Upper 31/32 |
| 0 | 1 | 0 | 1 | 1 | 8 to 127 | 080000H-7FFFFH | 7680KB | Upper 15/16 |
| 0 | 1 | 1 | 0 | 0 | 16 to 127 | 100000H-7FFFFFH | 7MB | Upper 7/8 |
| 0 | 1 | 1 | 0 | 1 | 32 to 127 | 200000H-7FFFFH | 6MB | Upper 3/4 |
| 0 | 1 | 1 | 1 | 0 | 64 to 127 | 400000H-7FFFFFH | 4MB | Upper 1/2 |
| Х | Х | 1 | 1 | 1 | NONE | NONE | NONE | NONE |
| 1 | 0 | 0 | 0 | 1 | 0 to 127 | 000000H-7FEFFFH | 8188KB | L-2047/2048 |
| 1 | 0 | 0 | 1 | 0 | 0 to 127 | 000000H-7FDFFFH | 8184KB | L-1023/1024 |
| 1 | 0 | 0 | 1 | 1 | 0 to 127 | 000000H-7FBFFFH | 8176KB | L-511/512 |
| 1 | 0 | 1 | 0 | Х | 0 to 127 | 000000H-7F7FFFH | 8160KB | L-255/256 |
| 1 | 0 | 1 | 1 | 0 | 0 to 127 | 000000H-7F7FFFH | 8160KB | L-255/256 |
| 1 | 1 | 0 | 0 | 1 | 0 to 127 | 001000H-7FFFFFH | 8188KB | U-2047/2048 |
| 1 | 1 | 0 | 1 | 0 | 0 to 127 | 002000H-7FFFFH | 8184KB | U-1023/1024 |
| 1 | 1 | 0 | 1 | 1 | 0 to 127 | 004000H-7FFFFFH | 8176KB | U-511/512 |
| 1 | 1 | 1 | 0 | Х | 0 to 127 | 008000H-7FFFFH | 8160KB | U-255/256 |
| 1 | 1 | 1 | 1 | 0 | 0 to 127 | 008000H-7FFFFH | 8160KB | U-255/256 |



Table1.2 XT25Q64D Individual Block Protection (WPS=1)

| Block | Sector | • | ess range | Individual Block Lock Operation |
|-------|--------|---------|-----------|---------------------------------|
| | 2047 | 7FF000H | 7FFFFFH | The Top/Bottom block |
| 127 | | | | is protected by sector. |
| | 2032 | 7F0000H | 7F0FFFH | Other 126 Blocks are |
| | | | | protected by block |
| | | | | Block Lock: |
| | | | | 36H+Address |
| 2 | | | | Block Unlock: 39H+Address |
| 1 | | | | Read Block Lock: 3DH+Address |
| | 15 | 00F000H | 00FFFFH | Global Block Lock: |
| 0 | | | | 7EH |
| | 0 | 000000Н | 000FFFH | Global Block Unlock: 98H |



5. COMMANDS DESCRIPTION

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-byte command code must be shifted in to the device, most significant bit first on SI, each bit being latched on the rising edges of SCLK.

See Table 2, every command sequence starts with a one-byte command code. Depending on the command, this might be followed by address bytes, or by data bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been shifted in. For the command of Read, Fast Read, Read Status Register or Release from Deep Power-Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. CS# can be driven high after any bit of the data-out sequence is being shifted out.

For the command of Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Write Enable or Write Disable command, CS# must be driven high exactly at the byte boundary, otherwise the command is rejected, and is not executed. That is CS# must be driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if at any time the input byte is not a full byte, nothing will happen and WEL will not be reset.

Table 2 Commands

| Command Name | Command Code | SPI | QPI | | Address Byte | | | | | Data Byte |
|---|-----------------|-----|-----|-------------------|--------------|-------|-------|-------|---------------------|--------------|
| | | | | Total ADD Byte | Byte1 | Byte2 | Byte3 | Byte4 | | |
| Register Access | | | | l | l | | l | l | l | |
| Read Status Register_1 | 05H | √ | √ | 0 | | | | | 0 | 1 to ∞ |
| Read Status Register_2 | 35H | √ | √ | 0 | | | | | 0 | 1 to ∞ |
| Read Status Register_3 | 15H | √ | √ | 0 | | | | | 0 | 1 to ∞ |
| Write Status Register_1 | 01H | √ | √ | 0 | | | | | 0 | 1 or 2 |
| Write Status Register_2 | 31H | √ | √ | 0 | | | | | 0 | 1 |
| Write Status Register_3 | 11H | √ | √ | 0 | | | | | 0 | 1 |
| Manufacturer/Device ID | 90H | √ | √ | 3 | | | | | 0 | 1 to ∞ |
| Read Serial Flash Discoverable Parameters | 5AH | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 8 ^{Note2} | 1 to ∞ |
| Read Unique ID | 4BH | √ | √ | 0 | | | | | 32 ^{Note2} | 1 to ∞ |
| Read Identification | 9FH | √ | √ | 0 | | | | | 0 | 1 to ∞ |
| Array access | | | I | | l | I | | • | l | |
| Read Data | 03H | √ | | 3 | ADD1 | ADD2 | ADD3 | | 0 | 1 to ∞ |
| Fast Read | OBH | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 8 ^{Note2} | 1 to ∞ |
| Dual Output Fast Read | 3BH | √ | | 3 | ADD1 | ADD2 | ADD3 | | 8 | 1 to ∞ |
| Dual I/O Fast Read | BBH | √ | | 3 | ADD1 | ADD2 | ADD3 | | 4 | 1 to ∞ |
| Quad Output Fast Read | 6BH | √ | | 3 | ADD1 | ADD2 | ADD3 | | 8 | 1 to ∞ |

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| Quad I/O Fast Read | EBH | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 6 ^{Note2 Note3} | 1 to ∞ |
|--|----------------------|-----|----------|---|------|------|------|---|--------------------------|-------------|
| Burst Read with Wrap | 0CH | | √ | 3 | ADD1 | ADD2 | ADD3 | | 4/6/8 ^{Note2} | 1 to ∞ |
| Quad Read under DTR | EDH | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 8/6 Note4 | 1 to ∞ |
| DTR Read with Wrap | 0EH | | √ | 3 | ADD1 | ADD2 | ADD3 | | 8/6 ^{Note4} | 1 to ∞ |
| Page Program | 02H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 0 | 1 to 256 |
| Quad Page Program | 32H | √ | | 3 | ADD1 | ADD2 | ADD3 | | 0 | 1 to 256 |
| Extended Quad Input Fast Program | C2h | √ | | 3 | ADD1 | ADD2 | ADD3 | | 0 | 1 to 256 |
| 4KB Sector Erase | 20H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 0 | 0 |
| 32KB Block Erase | 52H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 0 | 0 |
| 64KB Block Erase | D8H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | | 0 | 0 |
| Chip Erase | C7/60H | √ | √ | 0 | | | | | 0 | 0 |
| Device Operations | | | | | | | | | | |
| Enable Reset | 66H | √ | √ | 0 | | | | | 0 | 0 |
| Reset | 99H | √ | √ | 0 | | | | | 0 | 0 |
| Write Enable | 06H | √ | √ | 0 | | | | | 0 | 0 |
| Write Enable for Volatile Status Register | 50H | √ | √ | 0 | | | | | 0 | 0 |
| Write Disable | 04H | √ | √ | 0 | | | | | 0 | 0 |
| Program Erase Suspend | 75H | √ | √ | 0 | | | | | 0 | 0 |
| Program Erase Resume | 7AH | √ | √ | 0 | | | | | 0 | 0 |
| Enable QPI | 38H | √ | | 0 | | | | | 0 | 0 |
| Disable QPI | FFH | | √ | 0 | | | | | 0 | 0 |
| Set Burst with Wrap | 77H | √ | | 0 | | | | | 0 | 0 |
| Set Read Parameters | СОН | | √ | 0 | | | | | 0 | 0 |
| Continuous Read Reset | FFH ^{Note1} | √ | √ | | | | | | | |
| Deep Power-Down | В9Н | √ | √ | 0 | | | | | 0 | 0 |
| Release From Deep Pow- er-Down | ABH | √ | √ | 0 | | | | | 0 | 0 |
| Release From Deep Pow- er-Down/Read Device ID | ABH | √ | √ | 0 | | | | | 24 ^{Note2} | 1 to ∞ |
| One-Time Programmable (| OTP) Operation | ons | <u>I</u> | I | I | I | 1 | 1 | <u> </u> | |

| Erase Security Register | 44H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 0 | 0 |
|--------------------------------|--------------|---|---|---|------|------|------|---------|----------|
| Program Security Regis- ter | 42H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 0 | 1 to 256 |
| Read Security Register | 48H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 8 Note2 | 1 to ∞ |
| Advanced Sector Protectio | n Operations | | | | | | | | l |
| Global Block Lock | 7EH | √ | √ | 0 | | | | 0 | 0 |
| Global Block Unlock | 98H | √ | √ | 0 | | | | 0 | 0 |
| Individual Block Lock | 36H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 0 | 0 |
| Individual Block Unlock | 39H | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 0 | 0 |
| Read Block Lock | 3DH | √ | √ | 3 | ADD1 | ADD2 | ADD3 | 0 | 1 |

Note1:

Under SPI mode and Continuous Read Mode, Command FFH will exit the Continuous Read mode.

Under QPI mode and Continuous Read Mode, The first time sending command FFH will exit the Continuous Read mode, the second time sending FFH will exit QPI mode.

Note2:

In QPI mode, the number of dummy clocks is con-figured by the "Set Read Parameters (COH)" command. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.

Note3:

M7-0 is counted for dummy clocks.

Note4:

For EDH at both SPI mode and QPI mode, and for 0EH under QPI mode, the number of dummy clocks is con-figured by the LC bit. The number of dummy clocks can be configured as either 8/6.

Table of ID Definitions:

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| Operation Code | MID7-MID0 | ID15-ID8 | ID7-ID0 |
|----------------|-----------|----------|---------|
| 9FH | ОВ | 60 | 17 |
| 90H | ОВ | | 16 |
| ABH | | | 16 |



5.1. Register Access

5.1.1. Read Status Register (05H or 35H or 15H)

The Read Status Register (RDSR) command is for reading the Status Register. The Status Register can be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write In Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code "05H", the SO will output Status Register bits S7~S0. For the command code "35H", the SO will output Status Register bits S15~S8. For the command code "15H", the SO will output Status Register bits S23~S16.

CS

SCLK

Command

Command

Command

Command

Register 1/2/3

Register 1/2/3

SO

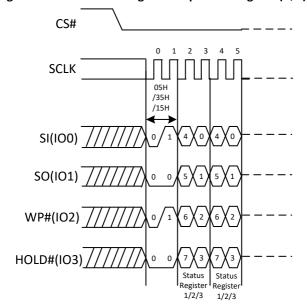
MSR

MSR

MSR

Figure 1. Read Status Register Sequence Diagram

Figure 1a. Read Status Register Sequence Diagram (QPI)





5.1.2. Write Status Register (01H or 31H or 11H)

The Write Status Register (WRSR) command allows new values to be written to the Status Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The Write Status Register (WRSR) command has no effect on the volatile bits of the Status Register. CS# must be driven high after the eighth bit or the sixteenth of the data byte has been latched in. If not, the Write Status Register (WRSR) command is not executed. As soon as CS# is driven high, the self-timed Write Status Register cycle (whose duration is tW) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Write Status Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

The Write Status Register (WRSR) command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, BP0) bits, to define the size of the area that is to be treated as read-only, as defined in Table 1.0 & 1.1. The Write Status Register (WRSR) command also allows the user to set or reset the Status Register Protect (SRP) bit in accordance with the Write Protect (WP#) signal. The Status Register Protect (SRP) bit and Write Protect (WP#) signal allow the device to be put in the Hardware Protected Mode. The Write Status Register (WRSR) command is not executed once the Hardware Protected Mode is entered. For command code "01H", the SI will input Status Register bits S15~S8. For the command code "11H", the SI will input Status Register bits S23~S16.

CS

SCLK

Command

Command

Status Register in

NSB

High-Z

SO

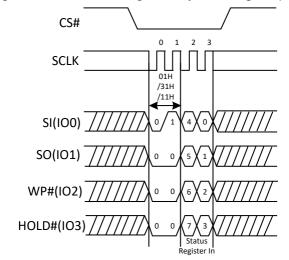
O1 2 3 4 5 6 7 8 9 10 11 12 13 14 15

SO

High-Z

Figure 2. Write Status Register Sequence Diagram

Figure 2a. Write Status Register Sequence Diagram (QPI)





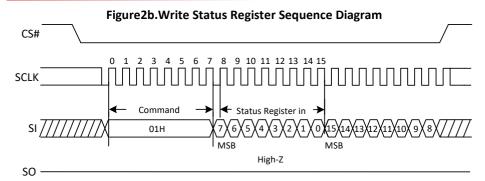
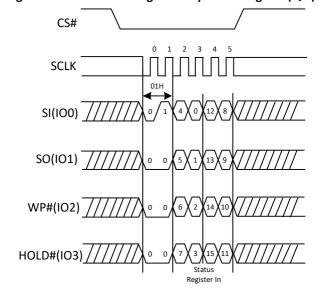


Figure2c. Write Status Register Sequence Diagram (QPI)





5.1.3. Read Manufacture ID/ Device ID (90H)

The Read Manufacturer/Device ID command is an alternative to the Release from Deep Power-Down and Read Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID.

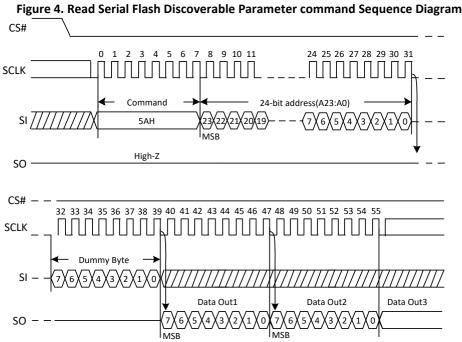
The command is initiated by driving the CS# pin low and shifting the command code "90H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first is shown in Figure 3. If the 24-bit address is initially set to 000001H, the Device ID will be read first.

Figure 3. Read Manufacture ID/ Device ID Sequence Diagram CS# SCLK Command SO CS# 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 Figure 3a. Read Manufacture ID/ Device ID Sequence Diagram (QPI) CS# **SCLK**



5.1.4. Read SFDP(5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be interrogated by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a standard of JEDEC Standard No.216.



Note: A23-A8 = 0, A7-A0 is the starting byte address for 256-byte SFDP Register.

Read Serial Flash Discoverable Parameter (5AH) in QPI mode

The Read Serial Flash Discoverable Parameter command is also supported in QPI mode. See the following figure . In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.

CS# **SCLK** HOLD#(IO3) /

Figure 4a. Read Serial Flash Discoverable Parameter command Sequence Diagram (QPI)

Set Read Parameters Command (COH) can set the number of dummy cycles



Table 4. Parameter Table (0): Signature and Parameter Identification Data Values

| Description | Comment | Add(H) | DW Add | Data | Data |
|--------------------------------|--------------------------------------|--------|--------|------|------|
| | | (Byte) | (Bit) | | |
| SFDP Signature | Fixed:50444653H | 00H | 07:00 | 53H | 53H |
| | | 01H | 15:08 | 46H | 46H |
| | | 02H | 23:16 | 44H | 44H |
| | | 03H | 31:24 | 50H | 50H |
| SFDP Minor Revision Number | Start from 00H | 04H | 07:00 | 06H | 06H |
| | Follow JESD216B standard | | | | |
| SFDP Major Revision Number | Start from 01H | 05H | 15:08 | 01H | 01H |
| | Follow JESD216B standard | | | | |
| Number of Parameters Headers | Start from 00H | 06H | 23:16 | 01H | 01H |
| Unused | Contains 0xFFH and can never be | 07H | 31:24 | FFH | FFH |
| | changed | | | | |
| ID number (JEDEC) | 00H: It indicates a JEDEC specified | 08H | 07:00 | 00H | 00H |
| | header | | | | |
| Parameter Table Minor Revision | Start from 00H | 09H | 15:08 | 06H | 06H |
| Number | Follow JESD216B standard | | | | |
| Parameter Table Major Revision | Start from 01H | 0AH | 23:16 | 01H | 01H |
| Number | Follow JESD216B standard | | | | |
| Parameter Table Length | How many DWORDs in the | 0BH | 31:24 | 10H | 10H |
| (in double word) | Parameter table | | | | |
| Parameter Table Pointer (PTP) | First address of JEDEC Flash | 0CH | 07:00 | 30H | 30H |
| | Parameter table | 0DH | 15:08 | 00H | 00H |
| | | 0EH | 23:16 | 00H | 00H |
| Unused | Contains 0xFFH and can never be | 0FH | 31:24 | FFH | FFH |
| | changed | | | | |
| ID Number | It is indicates XTX | 10H | 07:00 | OBH | ОВН |
| (XTX Manufacturer ID) | manufacturer ID | 1011 | 07.00 | 0511 | 0511 |
| Parameter Table Minor Revision | Start from 0x00H | 11H | 15:08 | 00H | 00H |
| Number | Start Holli oxeen | 1211 | 13.00 | 0011 | 0011 |
| Parameter Table Major Revision | Start from 0x01H | 12H | 23:16 | 01H | 01H |
| Number | Start Holli Oxoli I | 12 | 23.10 | 0211 | 0111 |
| Parameter Table Length | How many DWORDs in the | 13H | 31:24 | 03H | 03H |
| (in double word) | Parameter table | 1511 | 31.24 | 0311 | 0311 |
| Parameter Table Pointer (PTP) | First address of XTX Flash Parameter | 14H | 07:00 | 90H | 90H |
| Tarameter rable rounter (FTF) | | | | | |
| | table | 15H | 15:08 | 00H | 00H |
| | | 16H | 23:16 | 00H | 00H |
| Unused | Contains 0xFFH and can never be | 17H | 31:24 | FFH | FFH |
| | changed | | | | |



Parameter Table (1): JEDEC Flash Parameter Tables

| | . , | | | | |
|---|---|---------|--------|----------|------|
| Description | Comment | Add(H) | DW Add | Data | Data |
| | | (Byte) | (Bit) | | |
| Block/Sector Erase Size | 00: Reserved; 01: 4KB erase; 10: Reserved; 11: Not support 4KB erase | | 01:00 | 01b | |
| Write Granularity | 0: Buffer size = 1Byte or <64Byte(32 Words) 1: Buffer Size = 64Byte(32 Words) or larger | | 02 | 1b | |
| Volatile Status Register Block Protect bits | 0: Nonvolatile status bit, support 06H and 50H 1: Volatile status bit | 30H | 03 | 0b | E5H |
| Write Enable Opcode Select for Writing to Volatile Status Registers | 0: Use 50H Opcode, 1: Use 06H Opcode, Note: If target flash status register is nonvolatile, then bits 3 and 4 must be set to 00b. | | 04 | Ob | |
| Unused | Contains 111b and can never be changed | | 07:05 | 111b | |
| 4KB Erase Opcode | | 31H | 15:08 | 20H | 20H |
| (1-1-2) Fast Read | 0 = NOT supported 1 = supported | | 16 | 1b | |
| Address Bytes Number used in addressing flash array | 00: 3Byte only, 01: 3 or 4Byte, 10: 4Byte only, 11: Reserved | | 18:17 | 00b | |
| Double Transfer Rate (DTR) clocking | 0 = NOT supported 1 = supported | 32H | 19 | 1b | F9H |
| (1-2-2) Fast Read | 0 = NOT supported 1 = supported | 3211 | 20 | 1b | 1311 |
| (1-4-4) Fast Read | 0 = NOT supported 1 = supported | | 21 | 1b | |
| (1-1-4) Fast Read | 0 = NOT supported 1 = supported | | 22 | 1b | |
| Unused | | | 23 | 1b | |
| Unused | | 33H | 31:24 | FFH | FFH |
| Flash Memory Density | | 37H:34H | 31:00 | 03FFFFFI | H |
| (1-4-4) Fast Read Number of Wait states | 0 0000b: Wait states (Dummy Clocks) not support 0 0100b: 4 Dummy Clocks (M7-M0 excluded) | 38H | 04:00 | 00100b | 44H |
| (1-4-4) Fast Read Number of Mode Bits | | 3011 | 07:05 | 010b | |
| (1-4-4) Fast Read Opcode | | 39H | 15:08 | EBH | EBH |
| (1-1-4) Fast Read Number of Wait states | 0 0000b: Wait states (Dummy Clocks) not support 0 1000b: 8 Dummy Clocks | ЗАН | 20:16 | 01000b | 08H |
| | | | 22.24 | 000b | |
| (1-1-4) Fast Read Number of Mode Bits | 000b:Mode Bits not support | | 23:21 | doob | |



| Description | Comment | Add(H) (Byte) | DW Add (Bit) | Data | Data |
|--|---|------------------|-----------------|--------|-------|
| (1-1-2) Fast Read Number of Wait states | 0 0000b: Wait states (Dummy Clocks) not support 0 1000b: 8 Dummy Clocks | 2011 | 04:00 | 01000b | 0011 |
| (1-1-2) Fast Read Number of Mode Bits | · | 3CH | 07:05 | 000b | 08H |
| (1-1-2) Fast Read Opcodex | | 3DH | 15:08 | ЗВН | ЗВН |
| (1-2-2) Fast Read Number of Wait states | 0 0000b: Wait states (Dummy Clocks) not support (M7-M0 excluded) | 3EH | 20:16 | 00000b | 80H |
| (1-2-2) Fast Read Number of Mode Bits | 000b:Mode Bits not support 100b: 8bit Mode Bits = 4 Dummy Clocks (M7-M0) | <u> </u> | 23:21 | 100b | |
| (1-2-2) Fast Read Opcode | | 3FH | 31:24 | ВВН | ВВН |
| (2-2-2) Fast Read | 0 = NOT supported 1 = supported | | 00 | 0b | |
| Unused | | 40H | 03:01 | 111b | FEH |
| (4-4-4) Fast Read | 0 = NOT supported 1 = supported | | 04 | 1b | |
| Unused | | | 07:05 | 111b | |
| Unused | | 43H:41H | 31:08 | 0xFFH | 0xFFH |
| Unused | | 45H:44H | 15:00 | 0xFFH | 0xFFH |
| (2-2-2) Fast Read Number of Wait states | 0 0000b: Wait states (Dummy Clocks) not support | 46H | 20:16 | 00000b | 00H |
| (2-2-2) Fast Read Number of of Mode Bits | 000b: Mode Bits not support | | 23:21 | 000b | |
| (2-2-2) Fast Read Opcode | | 47H | 31:24 | FFH | FFH |
| Unused | | 49H:48H | 15:00 | 0xFFH | 0xFFH |
| (4-4-4) Fast Read Number of Wait states(QPI) | 0 0000b: Wait states (Dummy Clocks) not support 0 0110b: 6 Dummy Clocks (M7-M0 excluded) | 4AH | 20:16 | 00110b | 46H |
| (4-4-4) Fast Read Number of Mode Bits | | | 23:21 | 010b | |
| (4-4-4) Fast Read Opcode | | 4BH | 31:24 | EBH | EBH |
| Erase Type 1 Size (4Kb) | Sector/block size=2^N Bytes 0x00b: this sector type don't exist | 4CH | 07:00 | 0CH | 0CH |
| Erase Type 1 Opcode | | 4DH | 15:08 | 20H | 20H |
| Erase Type 2 Size (32Kb) | Sector/block size=2^N Bytes 0x00b: this sector type don't exist | 4EH | 23:16 | 0FH | 0FH |
| Erase Type 2 Opcode | | 4FH | 31:24 | 52H | 52H |
| Erase Type 3 Size (64Kb) | Sector/block size=2^N Bytes 0x00b: this sector type don't exist | 50H | 07:00 | 10H | 10H |
| Erase Type 3 Opcode | | 51H | 15:08 | D8H | D8H |
| Erase Type 4 Size (256Kb) | Sector/block size=2^N Bytes 0x00b: this sector type don't exist | 52H | 23:16 | 00H | 00H |
| Erase Type 4 Opcode | | 53H | 31:24 | FFH | FFH |



| Description | Comment | Add(H) (Byte) | DW Add (Bit) | Data | Data |
|---|---|------------------|-----------------|----------|---------------|
| Multiplier from typical erase time to maximum erase time | Erase Type n=1 Maximum erase time = 2*(Count + 1)* Typical Erase Time | | 3:0 | 0100b | |
| Erase Type 1 Erase, Typical time | Erase time=45ms/48ms | 54H:55H | 8:4 | 00010b | 1 |
| | | | 10:9 | 01b | 1 |
| Erase Type 2 Erase, Typical time | Erase time=120ms/128ms | | 15:11 | 00111b | FEA5 3A24H |
| | | | 17:16 | 01b | |
| Erase Type 3 Erase, Typical time | Erase time=150ms/160ms | | 22:18 | 01001b | 1 |
| | | 56H:57H | 24:23 | 01b | 1 |
| Erase Type 4 Erase, Typical time | Not exist | | 31:25 | 1111111b | 1 |
| Multiplier from typical time to max time for Page or Byte program | Maximum Page program time = 2*(Count + 1)* Typical Time | 58H | 3:0 | 0001b | 81H |
| Page Size | Page size=256Byte | 3011 | 7:4 | 1000b | 3111 |
| Page Program Typical time | Page program=400us/448us | | 13:8 | 100110b | |
| Byte Program Typical time, first | First Byte program=30us/32us | — 59H | 15:14 | 11b | E6H |
| Byte | | | 18:16 | 100b | |
| Byte Program Typical time, | Additional Byte program=2.5us/3us | 5AH | 23:19 | 00010b | 14H |
| additional Byte Chip Erase, Typical time | Chip erase typical time=20s/20s | | 30:24 | 1000100b | |
| Reserved | completed typical time 203/203 | - 5BH | 31 | 0b | 44H |
| Prohibited Operations During | | | 3:0 | 1000b | |
| Program Suspend | | | | | |
| Prohibited Operations During Erase Suspend | | 5CH | 7:4 | 1010b | A8H |
| Reserved | | | 8 | 0b | |
| Program Resume to Suspend Interval | Interval=100us/128us | 5DH | 12:9 | 0001b | 62H |
| Suspend in-progress program | max latency=20us/20us | | 15:13 | 011b | |
| max latency | | | 19:16 | 0110b | |
| Erase Resume to Suspend | Interval=100us/128us | 5EH | 23:20 | 0001b | 16H |
| Suspend in-progress erase max latency | max latency=20us/20us | | 30:24 | 0110011b | |
| Suspend / Resume supported | 0=supported 1=NOT supported | 5FH | 31 | Ob | 33H |
| Program Resume Instruction | | 60H | 7:0 | 7AH | 7AH |
| Program Suspend Instruction | | 61H | 15:0 | 75H | 75H |
| Resume Instruction | | 62H | 23:16 | 7AH | 7AH |
| Suspend Instruction | | 63H | 31:24 | 75H | 75H |



| Description | Comment | Add(H) (Byte) | DW Add (Bit) | Data | Data |
|---|---|------------------|-----------------|-----------|------|
| Reserved | | (Byte) | 1:0 | 11b | |
| Status Register Polling Device | Use of legacy polling is supported by reading the Status Register with 05h in- | 64H | 7:2 | 111101b | F7H |
| Busy | struction and checking WIP bit[0] | | 14.0 | 0100101b | |
| Exit Deep Power-Down to next | Delay=6us/6us | | 14:8 | 01001010 | |
| operation delay Exit Deep Power-Down Instruction | ABH | 65H | 15 | 1b | A5H |
| | | | 22:16 | 1010101b | |
| Enter Deep Power-Down Instruction | В9Н | 66H | 23 | 1b | D5H |
| instruction | | _ | 30:24 | 1011100b | _ |
| Deep Power-Down Supported | 0 = supported 1 = NOT supported | 67H | 31 | 0b | 5CH |
| 4-4-4 mode disable sequences | Issue FFH or 66/99H, set 1001b; If QPI not supported, set all bit to 0; | COLL | 3:0 | 1001b | 1011 |
| 4-4-4 mode enable sequences | x_xxx1x: Issue instruction 38H; x_xxxx1: Set QE bit, then issue instruction 38H; | 68H | 7:4 | 0001b | 19H |
| | If QPI not supported, set all bit to 0; | | 8 | 0b | |
| 0-4-4 mode supported | 0 = NOT supported 1 = supported | | 9 | 1b | |
| 0-4-4 Mode Exit Method | xx_xxx1b: Mode Bits[7:0] = 00h will terminate this mode at the end of the current read operation xx_x1xxb/1x_xxxxb: Reserved xx_1xxxb: Input Fh (mode bit reset) on IOO-IO3 for 8 clocks. This will terminate the mode prior to the next read operation. | 69Н | 15:10 | 101101b | В6Н |
| 0-4-4 Mode Entry Method | xxx1b: Mode Bits[7:0] = A5h Note: QE must be set prior to using this mode. x1xxb: Mode Bit[7:0]=AXh. 1xxxb: Reserved. | | 19:16 | 1101b | |
| Quad Enable Requirements (QER) | 100b: QE is bit 1 of status register 2. It is set via Write Status with two data bytes where bit 1 of the second byte is one. It is cleared via Write Status with two data bytes where bit 1 of the second byte is zero. Writing one byte to the status register does not modify status register 2. | 6АН | 22:20 | 100b | 4DH |
| RESET Disable | 1=Set Extended Configuration Register bit 4 to disable HOLD or RESET; 0=not support; | | 23 | Ob | |
| Reserved | | 6BH | 31:24 | 11111111b | FFH |



| Volatile or Non-Volatile Register | x1x_xxxxb/1xx_xxxxb: Reserved | | 6:0 | 1101000b | |
|---|--|-----|-------|----------|-----|
| and Write Enable Instruction for | xxx_1xxxb: Non-Volatile/Volatile status register 1 powers-up to last written val- | | | | |
| Status Register 1 | ue in the non-volatile status register, use instruction 06h to enable write to non-volatile status register. Volatile status register may be activated after power-up to override the non-volatile status register, use instruction 50h to enable write and activate the volatile status register. | 6СН | | | E8H |
| Reserved | | | 7 | 1b | |
| Soft Reset and Rescue Sequence Support | 66н-99н | 6DH | 13:8 | 010000b | 10H |
| Exit 4-Byte Addressing | Reserved | | 15:14 | 00b | -0 |
| | | 6EH | 23:16 | 0000000b | 00H |
| Enter 4-Bye Addressing | Reserved | 6FH | 31:24 | 0000000b | 00H |



Parameter Table (2): XTX Flash Parameter Tables

| | Farameter Table (2). ATA Flash | | | | |
|--|---|------------------|-----------------|---------------------|-------|
| Description | Comment | Add(H) (Byte) | DW Add (Bit) | Data | Data |
| Vcc Supply Maximum Voltage | 1600H=1.600V 1950H=1.950V 2000H=2.000V 2100H=2.100V 3600H=3.600V | 91H:90H | 15:00 | 2000Н | 2000H |
| Vcc Supply Minimum Voltage | 1140H=1.140V 1650H=1.650V 2700H=2.700V | 93H:92H | 31:16 | 1650H | 1650H |
| HW Reset# pin | 0 = NOT supported 1 = supported | | 00 | 1b | F99FН |
| HW Hold# pin | 0 = NOT supported 1 = supported | | 01 | 1b | |
| Deep Power Down Mode | 0 = NOT supported 1 = supported | | 02 | 1b | |
| SW Reset | 0 = NOT supported 1 = supported | | 03 | 1b | |
| SW Reset Opcode | Should be issue Reset Enable(66H) before Reset command. | 95H:94H | 11:04 | 1001 1001b (99H) | |
| Program Suspend/Resume | 0 = NOT supported 1 = supported | | 12 | 1b | |
| Erase Suspend/Resume | 0 = NOT supported 1 = supported | | 13 | 1b | |
| Unused | | 1 | 14 | 1b | |
| Wrap-Around Read mode | 0 = NOT supported 1 = supported | | 15 | 1b | |
| Wrap-Around Read mode Opcode | | 96H | 23:16 | 77H | 77H |
| Wrap-Around Read data length | 08H:support 8Byte wrap-around read 16H:8B&16Byte 32H:8B&16B&32Byte 64H:8B&16B&32B&64Byte | 97H | 31:24 | 64H | 64H |
| Individual block lock | 0 = NOT supported 1 = supported | | 00 | 1b | E8D9H |
| Individual block lock bit (Volatile/Nonvolatile) | 0=Volatile 1=Nonvolatile | | 01 | Ob | |
| Individual block lock Opcode | | 9вн:98н | 09:02 | 36H | |
| Individual block lock Volatile Protect bit default protect status | 0=protected 1=unprotected | | 10 | Ob | |
| Secured OTP | 0 = NOT supported 1 = supported | | 11 | 1b | |
| Read Lock | 0 = NOT supported 1 = supported | | 12 | Ob | |
| Permanent Lock | 0 = NOT supported 1 = supported | | 13 | 1b | |
| Unused | | | 15:14 | 11b | |
| Unused | | | 31:16 | FFFFH | FFFFH |

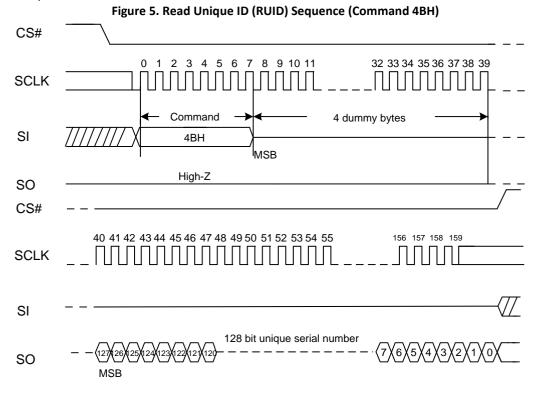


5.1.5. Read Unique ID(4BH)

The Read Unique ID command accesses a factory-set read-only 128bit number that is unique to each device. The Unique ID can be used in conjunction with user software methods to help prevent copying or cloning of a system.

The Read Unique ID command sequence: CS# goes low \rightarrow sending Read Unique ID command \rightarrow 4 dummy bytes \rightarrow 128bit Unique ID Out \rightarrow CS# goes high.

The command sequence is show below.



Read Unique ID (4BH) in QPI mode

The Read Unique ID command is also supported in QPI mode. See the figure below, In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.

SCLK

SI(IO0)

WP#(IO2)

*Set Read Parameters Command (COH) can set the number of dummy cycles

Figure 5a. Read Unique ID (RUID) Sequence (Command 4BH) (QPI)

CS#

SCLK

SI(IO0)

1

2

3

4

5

6

7

8

9

10

11

4

0

7

3

Dummy*

*Set Read Parameters Command (COH) can set the number of dummy cycles

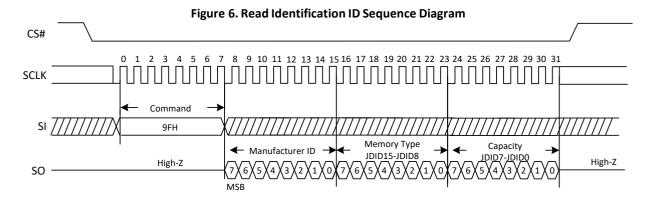
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5.1.6. Read Identification (9FH)

The Read Identification (RDID) command allows the 8-bit manufacturer identification to be read, followed by two bytes of device identification. The device identification indicates the memory type in the first byte, and the memory capacity of the device in the second byte. Any Read Identification (RDID) command while an Erase or Program cycle is in progress will not be decoded, and has no effect on the cycle that is in progress. The Read Identification (RDID) command should not be issued while the device is in Deep Power-Down Mode.

The device is first selected by driving CS# to low. Then, the 8-bit command code for the command is shifted in. This is followed by the 24-bit manufacture identification and device identification, stored in the memory, being shifted out on Serial Data Output, each bit being shifted out during the falling edge of Serial Clock. The command sequence is shown in Figure 6. The Read Identification (RDID) command is terminated by driving CS# to high at any time during data output. When CS# is driven high, the device is put in the Standby Mode. Once in the Standby Mode, the device waits to be selected, so that it can receive, decode and execute commands.



SCLK

SI(IO0)

WP#(IO2)

HOLD#(IO3)

Sigure 6a. Read Identification ID Sequence Diagram (QPI)

Sequence Diagram (QPI)

Sequence Diagram (QPI)

1 2 3 4 5 6 7

SCLK

SI(IO0)

0 1 5 1 5 1 5 1

VP 4 0 4 0 4 0

1 1 7 3 7 3 7 3 7 3

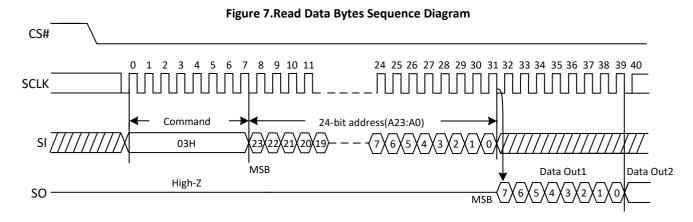
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5.2. Array access

5.2.1. Normal Read (03H)

The Read Data Bytes (READ) command is followed by a 3-byte address (A23-A0), each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency fR, during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes (READ) command. Any Read Data Bytes (READ) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.



5.2.2. Fast Read (0BH)

The Read Data Bytes at Higher Speed (Fast Read) command is for quickly reading data out. It is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency fC, during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out.

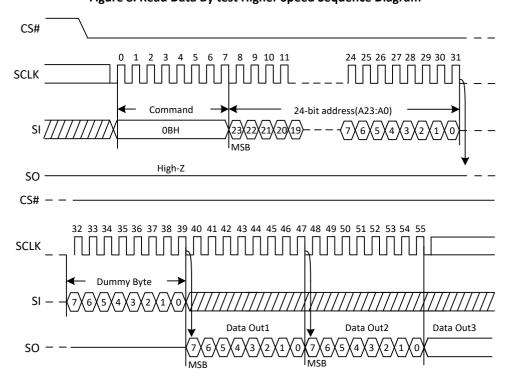
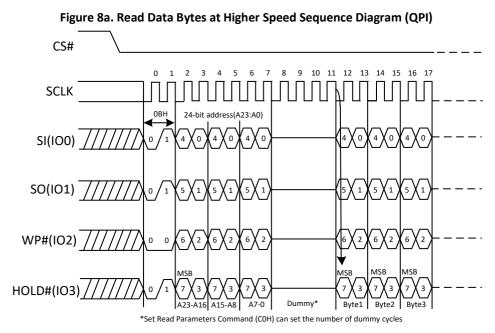


Figure 8. Read Data By test Higher Speed Sequence Diagram



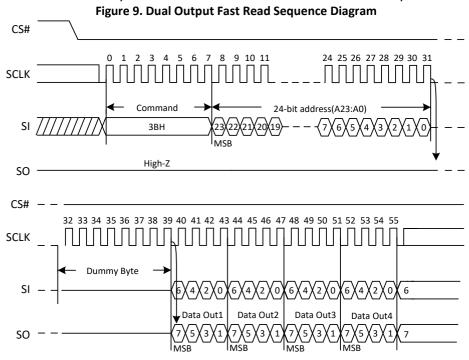
Fast Read (0BH) in QPI mode

The Fast Read command is also supported in QPI mode. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.



5.2.3. Dual Output Fast Read (3BH)

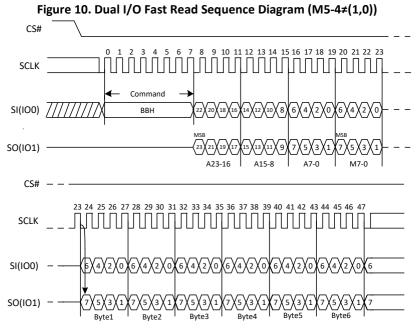
The Dual Output Fast Read command is followed by 3-byte address (A23-A0) and a dummy byte, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in the following figure. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out.





5.2.4. Dual I/O Fast Read(BBH)

The Dual I/O Fast Read command is similar to the Dual Output Fast Read command but with the capability to input the 3-byte address (A23-0) and a "Continuous Read Mode" byte 2-bit per clock by SI and SO, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in the following figure. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out.



Dual I/O Fast Read with "Continuous Read Mode"

The Dual I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5-4) =(1, 0), then the next Dual I/O Fast Read command (after CS# is raised and then lowered) does not require the BBH command code. The command sequence is shown in figure below. If the "Continuous Read Mode" bits (M5-4) do not equal (1, 0), the next command requires the first BBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5-4) before issuing normal command.

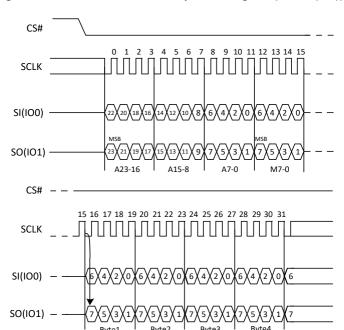
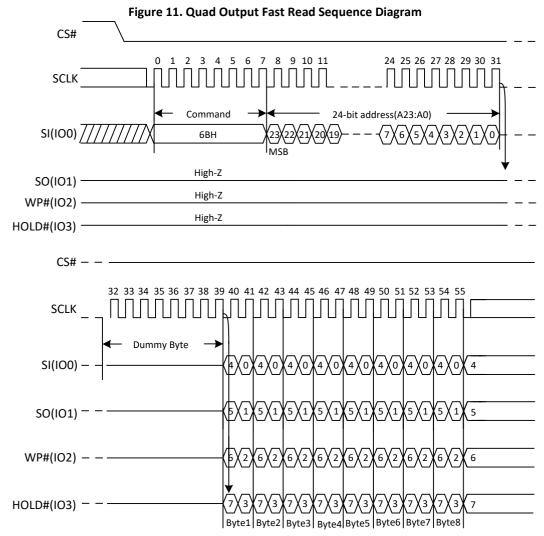


Figure 10a. Dual I/O Fast Read Sequence Diagram (M5-4=(1,0))



5.2.5. Quad Output Fast Read(6BH)

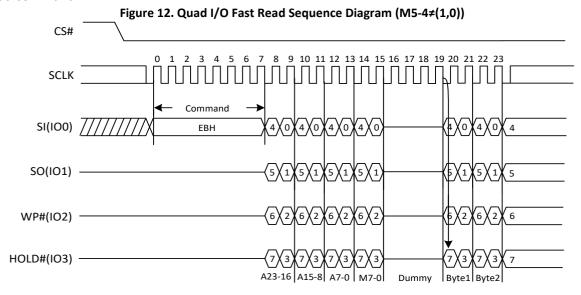
The Quad Output Fast Read command is followed by 3-byte address (A23-A0) and a dummy byte, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO3, IO2, IO1 and IO0. The command sequence is shown in the figure below. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out.





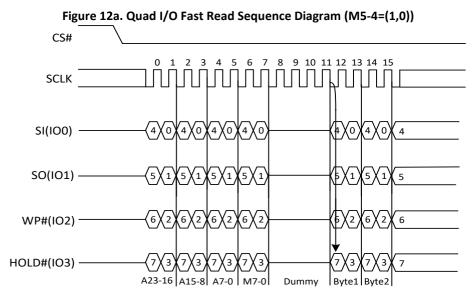
5.2.6. Quad I/O Fast Read(EBH)

The Quad I/O Fast Read command is similar to the Dual I/O Fast Read command but with the capability to input the 3-byte address (A23-0) and a "Continuous Read Mode" byte and 4-dummy clock 4-bit per clock by IOO, IO1, IO3, IO4, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IOO, IO1, IO2, IO3. The command sequence is shown in the figure below. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out. The Quad Enable bit (QE) of Status Register (S9) must be set to enable for the Quad I/O Fast read command.



Quad I/O Fast Read with "Continuous Read Mode"

The Quad I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5-4) =(1, 0), then the next Quad I/O Fast Read command (after CS# is raised and then lowered) does not require the EBH command code. The command sequence is shown in Figure 12a. If the "Continuous Read Mode" (M5- 4) do not equal (1, 0), the next command requires the first EBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5- 4) before issuing normal command.



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Quad I/O Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

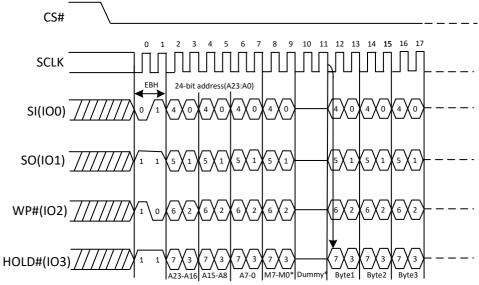
The Quad I/O Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to EBH. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following EBH commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands.

Quad I/O Fast Read (EBH) in QPI mode

The Quad I/O Fast Read command is also supported in QPI mode. See the figure below. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8. In QPI mode, the "Continuous Read Mode" bits M7-M0 are also considered as dummy clocks. "Continuous Read Mode" feature is also available in QPI mode for Quad I/O Fast Read command. The "Wrap Around" feature is also available in QPI mode for Quad I/O Fast Read command. To use the "Wrap Around" Feature, the P2 in the "Set Read Parameters (COH)" instruction in the QPI mode must be set to 0. To exit the "Wrap Around" Feature, the P2 in the "Set Read Parameters (COH)" instruction in the QPI mode must be set to 1. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (COH)" instruction.

Figure 12b. Quad I/O Fast Read Sequence Diagram (M5-4= (1, 0) QPI)



*Set Read Parameters Command (COH) can set the number of dummy cycles



5.2.7. Burst Read With Wrap(0CH)

The "Burst Read with Wrap (OCH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (OBH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (COH)" command.

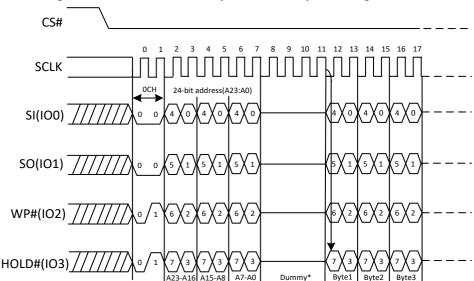


Figure 14. Burst Read with Wrap command Sequence Diagram

Note: The "Burst Read with Wrap (OCH)" instruction can always perform "Wrap Around" regardless of the Status of P2 in the "Set Read Parameters (COH)" instruction in the QPI mode.



5.2.8. DTR Fast Read Quad I/O (EDH)

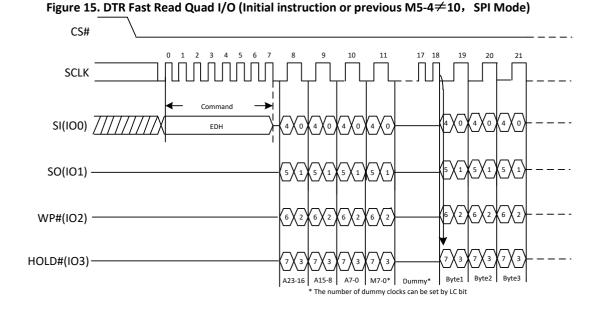
The DTR Fast Read Quad I/O (EDH) instruction is similar to the Fast Read Quad I/O (EBH) instruction except that address and data bits are input and output twice for each clock through four pins IOO, IO1, IO2 and IO3 and several Dummy clocks(including M7-M0) are required in SPI mode prior to the data output. The Quad I/O dramatically reduces instruction overhead allowing faster random access for code execution (XIP) directly from the Quad SPI. The Quad Enable bit (QE) of Status Register must be set to enable the DTR Fast Read Quad I/O Instruction.

The number of dummy clocks for "DTR Fast Read Quad I/O" (EDH) can be set by the Latency Code (LC) in status register. When the LC bit is set to 0, which is default, the number of dummy clock cycles is 8. When the LC bit is set to 1, the number of dummy clock cycles is 6.

DTR Fast Read Quad I/O with "Continuous Read Mode"

The DTR Fast Read Quad I/O instruction can further reduce instruction overhead through setting the "Continuous Read Mode" bits (M7-0) after the input Address bits (A23-0), as shown in "6BH" command description. The upper nibble of the (M7-4) controls the length of the next DTR Fast Read Quad I/O instruction through the inclusion or exclusion of the first byte instruction code. The lower nibble bits of the (M3-0) are don't care ("x"). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the "Continuous Read Mode" bits M5-4 = (1,0), then the next DTR Fast Read Quad I/O instruction (after /CS is raised and then lowered) does not require the EBH instruction code. This reduces the instruction sequence by eight clocks and allows the Read address to be immediately entered after /CS is asserted low. If the "Continuous Read Mode" bits M5-4 do not equal to (1,0), the next instruction (after /CS is raised and then lowered) requires the first byte instruction code, thus returning to normal operation. It is recommended to input FFh/3FFh on IOO for the next instruction (8/10 clocks), to ensure M4 = 1 and return the device to normal operation.



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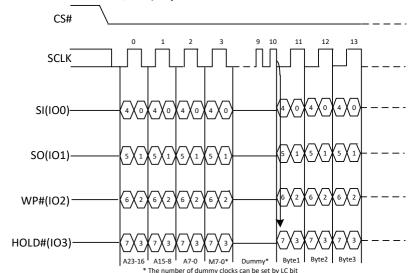


Figure 15a. DTR Fast Read Quad I/O (Previous instruction set M5-4=10, SPI Mode)

DTR Fast Read Quad I/O with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The DTR Fast Read Quad I/O instruction can also be used to access a specific portion within a page by issuing a "Set Burst with Wrap" (77H) command prior to EDH. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following EDH commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8, 16, 32 or 64-byte section of a 256-byte page. The output data starts at the initial address specified in the instruction, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around to the beginning boundary automatically until /CS is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands.

DTR Fast Read Quad I/O (EDH) in QPI Mode

The DTR Fast Read Quad I/O instruction is also supported in QPI mode, as shown in the figure below. In QPI mode, the "Continuous Read Mode" bits M7-0 are also considered as dummy clocks. In the default setting, the data output will follow the Continuous Read Mode bits immediately.

"Continuous Read Mode" feature is also available in QPI mode for DTR Fast Read Quad I/O instruction. Please refer to the description on previous pages.

The "Wrap Around" feature is also available in QPI mode for DTR Fast Read Quad I/O instruction. To use the "Wrap Around" Feature, the P2 in the "Set Read Parameters (COH)" instruction in the QPI mode must be set to 0. To exit the "Wrap Around" Feature, the P2 in the "Set Read Parameters (COH)" instruction in the QPI mode must be set to 1. The "Wrap Length" can be configured by the "Set Read Parameters (COH)" instruction.

The number of dummy clocks for "DTR Fast Read Quad I/O" (EDH) can be set by the Latency Code (LC) in status register. When the LC bit is set to 0, which is default, the number of dummy clock cycles is 8. When the LC bit is set to 1, the number of dummy clock cycles is 6.



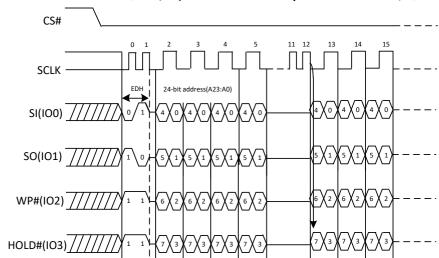


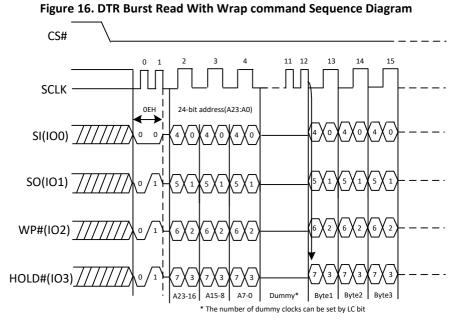
Figure 15b. DTR Fast Read Quad I/O (Initial instruction or previous M5-4≠10, QPI Mode)

5.2.9. DTR Burst Read With Wrap(0EH)

The "DTR Burst Read with Wrap (0Eh)" instruction provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. The instruction is similar to the "Fast Read (0Bh)" instruction in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Length" once the ending boundary is reached.

The number of dummy clocks can be set by the Latency Code (LC) in status register. When the LC bit is set to 0, which is default, the number of dummy clock cycles is 8. When the LC bit is set to 1, the dummy clock cycles is 6.

The "Wrap Length" can be configured by the "Set Read Parameters (COH)" instruction.



Note: The "DTR Burst Read with Wrap (0EH)" instruction can always perform "Wrap Around" regardless of the Status of P2 in the "Set Read Parameters (COH)" instruction in the QPI mode.



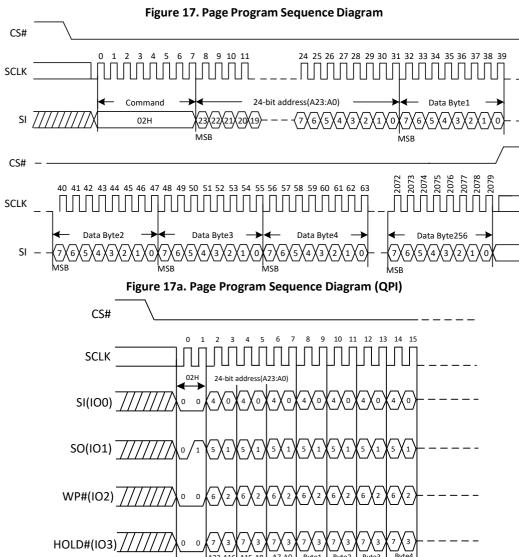
5.2.10. Page Program(02H)

The Page Program (PP) command is for programming the memory. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command.

The Page Program (PP) command is entered by driving CS# Low, followed by the command code, three address bytes and at least one data byte on SI. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven low for the entire duration of the sequence. The Page Program command sequence: CS# goes low →sending Page Program command → 3-byte address on SI → at least 1 byte data on SI →CS# goes high. The command sequence is shown in Figure 17. If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Page Program cycle (whose duration is tPP) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) is not executed.





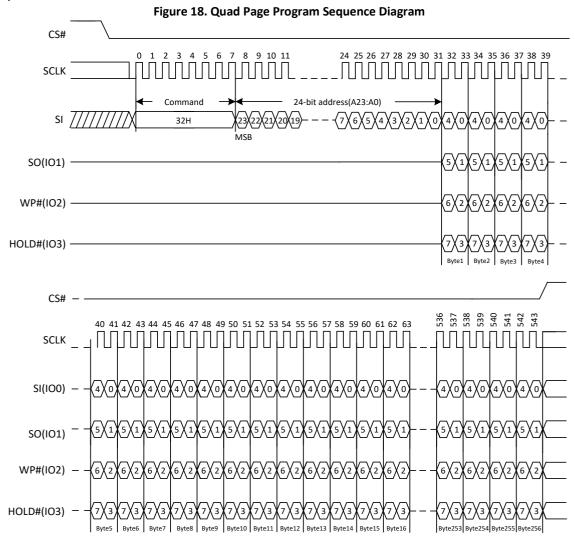
5.2.11. Quad Page Program(32H)

The Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. To use Quad Page Program, the Quad Enable bit in status register Bit9 must be set (QE=1). A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The Quad Page Program command is entered by driving CS# Low, followed by the command code (32H), three address bytes and at least one data byte on IO pins.

The command sequence is shown in the figure below. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Quad Page Program command will not be executed.

As soon as CS# is driven high, the self-timed Quad Page Program cycle (whose duration is tPP) is initiated. While the Quad Page Program cycle is in progress, the Status Register can be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) will not be executed.





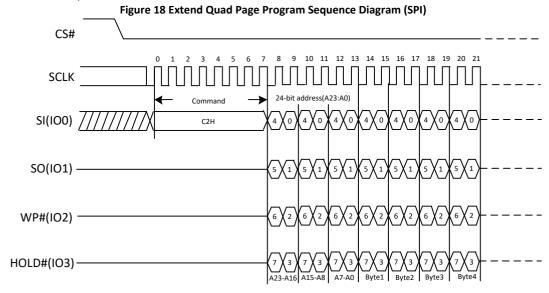
5.2.12. Extend Quad Page Program (C2H)

The Extend Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The extend quad Page Program command is entered by driving CS# Low, followed by the command code (C2H), three address bytes and at least one data byte on IO pins.

If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Extend Quad Page Program (EPP) command is not executed.

As soon as CS# is driven high, the self-timed Extend Quad Page Program cycle (whose duration is tPP) is initiated. While the Extend Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Extend Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

An Extend Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.



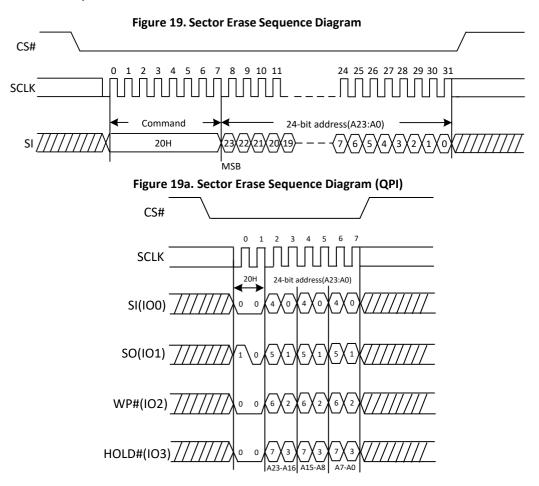


5.2.13. Sector Erase(20H)

The Sector Erase (SE) command is for erasing all the data of the chosen sector. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Sector Erase command. The Sector Erase (SE) command is entered by driving CS# low, followed by the command code, and 3-address byte on SI. Any address inside the sector is a valid address for the Sector Erase (SE) command.

The Sector Erase command sequence: CS# goes low→ sending Sector Erase command→ 3-byte address on SI→ CS# goes high. The command sequence is shown in Figure 19. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the Sector Erase (SE) command will not be executed. As soon as CS# is driven high, the self-timed Sector Erase cycle (whose duration is tSE) is initiated. While the Sector Erase cycle is in progress, the Status Register can be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Sector Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A Sector Erase (SE) command applied to a sector which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bit (see Table 1.0 & 1.1) will not be executed.

Note: Power disruption during erase operation will cause incomplete erase, thus it is recommended to perform a re-erase once power resume.



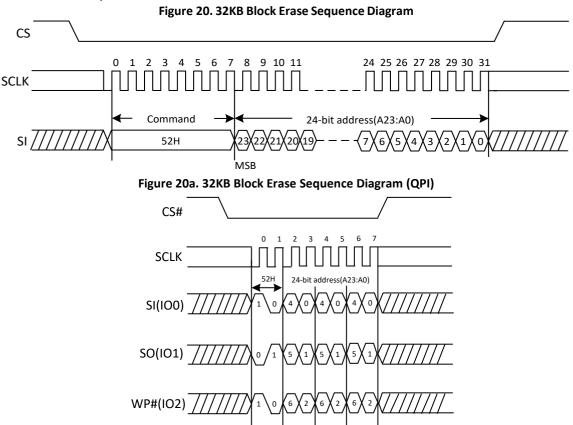


5.2.14. 32k Block Erase(52H)

The 32KB Block Erase (BE) command is for erasing all the data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the 32KB Block Erase command. The 32KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and three address bytes on SI, driving CS# high. Any address inside the block is a valid address for the 32KB Block Erase (BE) command.

The 32KB Block Erase command sequence: CS# goes low→ sending 32KB Block Erase command→ 3-byte address on SI→CS# goes high. The command sequence is shown in Figure 20. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 32KB Block Erase (BE) command will not be executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is tBE) is initiated. While the Block Erase cycle is in progress, the Status Register can be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 32KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits (see Table1.0 & 1.1) will not be executed.

Note: Power disruption during erase operation will cause incomplete erase, thus it is recommended to perform a re-erase once power resume.



HOLD#(IO3)

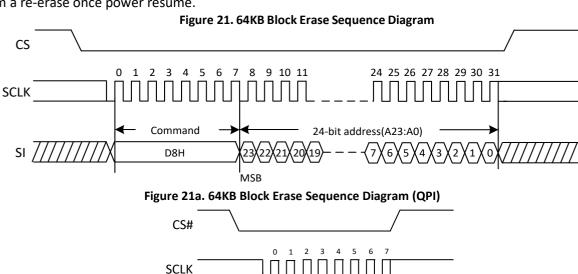


5.2.15. 64k Block Erase(D8H)

The 64KB Block Erase (BE) command is for erasing all the data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit, before sending the 64KB Block Erase command. The 64KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and three address bytes on SI, driving CS# high. Any address inside the block is a valid address for the 64KB Block Erase (BE) command.

The 64KB Block Erase command sequence: CS# goes low →sending 64KB Block Erase command → 3-byte address on SI→CS# goes high. The command sequence is shown in Figure 21. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 64KB Block Erase (BE) command will not be executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is tBE) is initiated. While the Block Erase cycle is in progress, the Status Register can be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 64KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits (see Table 1.0 & 1.1) will not be executed.

Note: Power disruption during erase operation will cause incomplete erase, thus it is recommended to perform a re-erase once power resume.



SCLK

D8H

24-bit address(A23:A0)

SO(IO1)

VP#(IO2)

1 0 6 2 6 2 6 2

HOLD#(IO3)

1 1 7 3 7 3 7 3

A23-A16 A15-A8 A7-A0



5.2.16. Chip Erase(60H or C7H)

The Chip Erase (CE) command is for erasing all the data of the chip. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit, before sending the Chip Erase command .The Chip Erase (CE) command is entered by driving CS# Low, followed by the command code on Serial Data Input (SI).

The Chip Erase command sequence: CS# goes low→ sending Chip Erase command→CS# goes high. The command sequence is shown in Figure 22. CS# must be driven high after the eighth bit of the command code has been latch in, otherwise the Chip Erase command will not be executed. As soon as CS# is driven high, the self-timed Chip Erase cycle (whose duration is tCE) is initiated. While the Chip Erase cycle is in progress, the Status Register can be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Chip Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Chip Erase (CE) command is ignored if one or more sectors are protected.

Note: Power disruption during erase operation will cause incomplete erase, thus it is recommended to perform a re-erase once power resume.

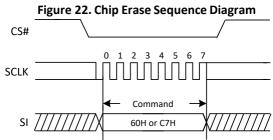
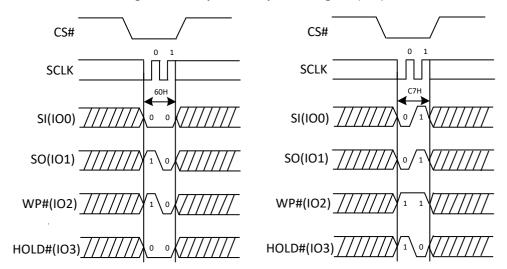


Figure 22a. Chip Erase Sequence Diagram (QPI)





5.3. Device Operations

5.3.1. Enable Reset (66H) and Reset (99H)

If the Reset command is accepted, any on-going internal operation will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch status (WEL), Read Parameter setting (P7-P0) and Wrap Bit Setting (W6-W4).

The "Reset (99H)" command sequence as follow: CS# goes low \rightarrow Sending Enable Reset command \rightarrow CS# goes high \rightarrow CS# goes low \rightarrow Sending Reset command \rightarrow CS# goes high. Once the Reset command is accepted by the device, the device will take approximately tRST_R to reset. During this period, no command will be accepted. Data corruption may happen if there is an on-going internal Erase or Program operation when Reset command sequence is accepted by the device. It is recommended to check the BUSY bit and the SUS bit in Status Register before issuing the Reset command sequence.

The Enable Reset (66H) command must be issued prior to a Reset(99H) command and any other commands can't be inserted between them. Otherwise, Enable Reset (66H) command will be cleared.

Figure 23. Enable Reset and Reset command Sequence Diagram

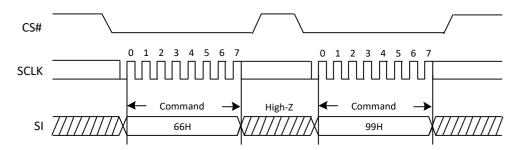
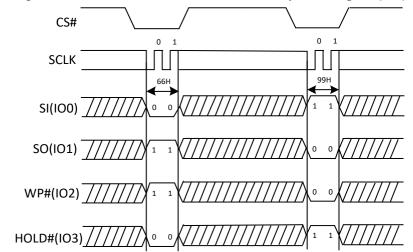


Figure 23a. Enable Reset and Reset command Sequence Diagram (QPI)





5.3.2. Write Enable(06H)

The Write Enable (WREN) command is for setting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit must be set prior to every Page Program (PP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE), Erase Security Register, Program Security Register and Write Status Register (WRSR) command. The Write Enable (WREN) command sequence: CS# goes low -> Sending the Write Enable command -> CS# goes high.

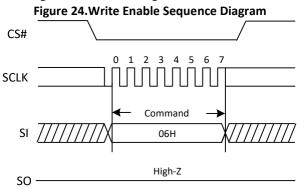
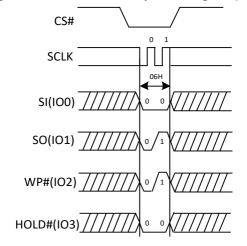


Figure 24a. Write Enable Sequence Diagram (QPI)





5.3.3. Write Enable for Volatile Status Register (50H)

The non-volatile Status Register bits can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. The Write Enable for Volatile Status Register command must be issued prior to a Write Status Register command and any other commands can't be inserted between them. Otherwise, Write Enable for Volatile Status Register will be cleared. The Write Enable for Volatile Status Register command will not set the Write Enable Latch bit, it is only valid for the Write Status Register command to change the volatile Status Register bit values.

CS#

SCLK

Command

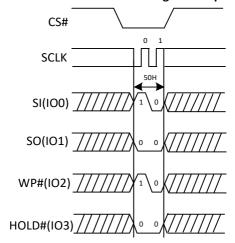
SI

SO

High-Z

Figure 25. Write Enable for Volatile Status Register Sequence Diagram

Figure 25a. Write Enable for Volatile Status Register Sequence Diagram (QPI)





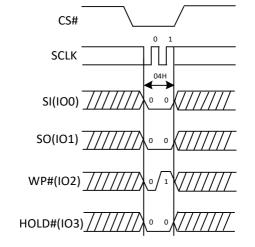
5.3.4. Write Disable(04H)

The Write Disable command is for resetting the Write Enable Latch (WEL) bit. The Write Disable command sequence: CS# goes low ->Sending the Write Disable command ->CS# goes high. The WEL bit is reset by following condition: Power-up and upon completion of the Write Status Register, Page Program, Sector Erase, Block Erase and Chip Erase commands.

Figure 26. Write Disable Sequence Diagram

CS# **SCLK** Command 04H High-Z

Figure 26a. Write Disable Sequence Diagram (QPI)



5.3.5. Program Erase Suspend(75H)

The Program/Erase Suspend command "75H", allows the system to interrupt a page program or sector/block erase operation and then read data from any other sector or block. The Write Status Register command (01H/31H/11H) and Erase/Program Security Registers command (44H,42H) and Erase commands (20H, 52H, D8H, C7H, 60H) and Page Program command (02H / 32H) are not allowed during Program suspend. The Write Status Register command (01H/31H/11H) and Erase Security Registers command (44H) and Erase commands (20H, 52H, D8H, C7H, 60H) are not allowed during Erase suspend. Program/Erase Suspend is valid only during the page program or sector/block erase operation. A maximum of time of "tSUS" (See AC Characteristics) is required to suspend the program/erase operation.

The Program/Erase Suspend command will be accepted by the device only if the SUS bit in the Status Register equal to 0 and WIP bit equal to 1 while a Page Program or a Sector or Block Erase operation is on-going. If the SUS bit equal to 1 or WIP bit equal to 0, the Suspend command will be ignored by the device. The WIP bit will be cleared form 1 to 0 within "tSUS" and the SUS bit will be set from 0 to 1 immediately after Program/Erase Suspend. A power-off during the suspend period will reset the device and release the suspend state. The command sequence is show in Figure 27.





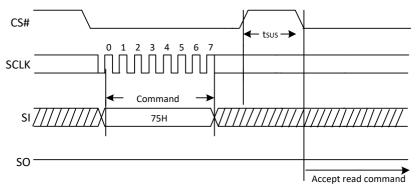
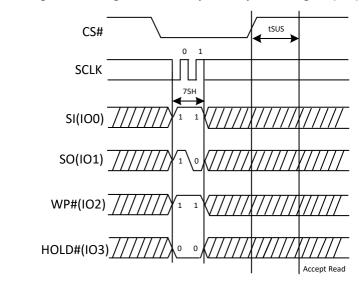


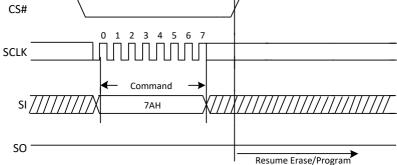
Figure 27a. Program/Erase Suspend Sequence Diagram(QPI)



5.3.6. Program Erase Resume (7AH)

The Program/Erase Resume command must be written to resume the program or sector/block erase operation after a Program/Erase Suspend command. The Program/Erase command will be accepted by the device only if the SUS bit equal to 1 and the WIP bit equal to 0. After issued the SUS bit in the status register will be cleared from 1 to 0 immediately, the WIP bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. The Program/Erase Resume command will be ignored unless a Program/Erase Suspend is active. The command sequence is show in Figure 28.

Figure 28. Program/Erase Resume Sequence Diagram





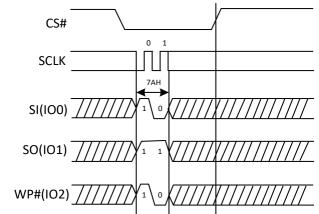


Figure 28a. Program/Erase Resume Sequence Diagram (QPI)

5.3.7. Enable QPI(38H)

The device support both Standard/Dual/Quad SPI and QPI mode. The "Enable QPI (38H)" command can switch the device from SPI mode to QPI mode. See the command Table 2 for all support QPI commands. In order to switch the device to QPI mode, the Quad Enable (QE) bit in Status Register must be set to 1 first, and "Enable QPI (38H)" command must be issued. If the QE bit is 0, the "Enable QPI (38H)" command will be ignored and the device will remain in SPI mode. When the device is switched from SPI mode to QPI mode, the existing Write Enable Latch and the Wrap Length setting will remain unchanged.

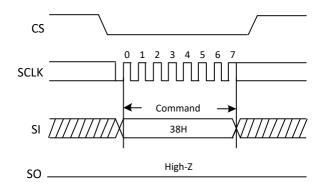


Figure 29. Enable QPI mode command Sequence Diagram



5.3.8. Continuous Read Mode Reset / Disable QPI (FFH)

The Dual/Quad I/O Fast Read operations, "Continuous Read Mode" bits (M7-0) are implemented to further reduce command overhead. By setting the (M7-0) to "AXH", the next Dual/Quad I/O Fast Read operations do not require the BBH/EBH /EDH command code. If Continuous Read Mode bits are set to "AXH", the device will not recognize any standard SPI commands. So Continuous Read Mode Reset command will release the Continuous Read Mode from the "AXH" state and allow standard SPI command to be recognized.

Mode Bit Reset for Quad/ Dual I/O CS# SI(IO0) FFH SO(IO1) / Don't care WP#(IO2) Don't care HOLD#(IO3) /// Don't care

Figure 30. Continuous Read Mode Reset Sequence Diagram

Disable QPI (FFH)

To exit the QPI mode and return to Standard/Dual/Quad SPI mode, the "Disable QPI (FFH)" command must be issued. When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch and the Wrap Length setting will remain unchanged. When the device is in QPI mode, the first FFH command will exit continuous read mode and the second FFH command will exit QPI mode.

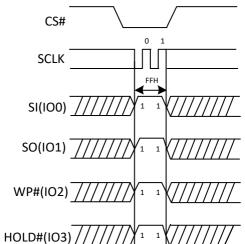


Figure 30a. Disable QPI mode command Sequence Diagram

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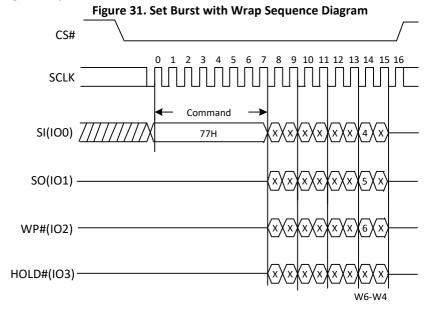
5.3.9. Set Burst With Wrap(77H)

The Set Burst with Wrap command is used in conjunction with "Quad I/O Fast Read (EBH)", and "Quad Read under DTR (EDH)" commands to access a fixed length of 8/16/32/64-byte section within a 256-byte page in standard SPI mode. The Set Burst with Wrap command sequence: CS# goes low \rightarrow Send Set Burst with Wrap command \rightarrow Send 24 dummy bits \rightarrow Send 8 bits "Wrap bits" \rightarrow CS# goes high

| VAIC VAIE | W4=0 | | W4=1(default) | |
|-----------|-------------|-------------|---------------|-------------|
| W6,W5 | Wrap Around | Wrap Length | Wrap Around | Wrap Length |
| 0,0 | Yes | 8-byte | No | N/A |
| 0,1 | Yes | 16-byte | No | N/A |
| 1,0 | Yes | 32-byte | No | N/A |
| 1,1 | Yes | 64-byte | No | N/A |

If the W6-W4 bits are set by the Set Burst with Wrap command, all the following "Quad I/O Fast Read (EBH)" and "Quad Read under DTR (EDH)" command will use the W6-W4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4=1.

In QPI mode, the "Burst Read with Wrap (0CH)" command should be used to perform the Read Operation with "Wrap Around" feature. The Wrap Length set by W5-W6 in Standard SPI mode is still valid in QPI mode and can also be re-configured by "Set Read Parameters (COH) command, and vice versa.





5.3.10. Set Read Parameters(C0H)

In QPI mode, to accommodate a wide range of applications with different needs for either maximum read-frequency or minimum data access latency, "Set Read Parameters (COH)" instruction can be used to configure the number of dummy clocks for "Fast Read (0BH)", "Fast Read Quad I/O (EBH)", "Burst Read with Wrap (0CH)", "Read SFDP (5AH)", "Read Unique ID (4BH)", "Read Security Register (48H)" and "Release From Deep Power-Down And Read Device ID (ABH)" instructions, and to configure the number of bytes of "Wrap Length" for "Fast Read Quad I/O (EBH)", "DTR Fast Read Quad I/O (EDH)", "DTR Burst Read with Wrap (0EH)" and "Burst Read with Wrap (0CH)" instruction. In Standard SPI mode, the "Set Read Parameters (COH)" instruction is not accepted.

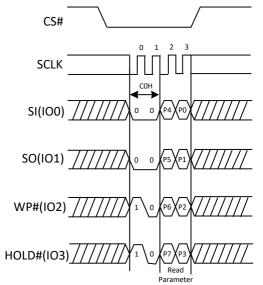
The dummy clocks for various Fast Read instructions in Standard/Dual/Quad SPI mode are fixed and will remain unchanged when the device is switched from Standard SPI mode to QPI mode and requires to be set again, prior to any OBH or EBH instructions. When the device is switched from QPI mode to SPI mode, the number of dummy clocks goes back to default.

The default "Wrap Length" after a power up or a Reset instruction is 8 bytes, the default number of dummy clocks is 8. The "Wrap Length" is set by W6-4 bit in the "Set Burst with Wrap (77H)" instruction in Standard SPI mode and by P1-P0 in the "Set Read Parameters (COH)" in the QPI mode. The Wrap Length set by P1-P0 in QPI mode is still valid in SPI mode and can also be re-configured by "Set Burst with Wrap (77H)", and vice versa.

COH adds an extra bit P2 for Disable/Enable Wrap function. Execute COH and then follows EBH or EDH, performs the read operation with "Wrap Around" in QPI mode. This function is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (COH)" command. Also OCH and OEH are alternative ways to perform "Wrap Around", they can always perform "Wrap Around" regardless of the Status of P2 in the "Set Read Parameters (COH)" instruction in the QPI mode.

| P5-P4 | Dummy Clocks | Maximum Read Freq. | P2 | P1-P0 | Wrap Length |
|---------------|-----------------|-----------------------|-----------------------------|--------------|-------------|
| 0 0 | 4 | 70MHz | Enable Wrap=0 | 0 0(Default) | 8-byte |
| 0 1 | 4 | 70MHz | Disable Wrap=1 (Default) | 01 | 16-byte |
| 10 | 6 | 108MHz | | 10 | 32-byte |
| 1 1 (Default) | 8 | 108MHz | | 11 | 64-byte |

Figure 31. Set Read Parameters command Sequence Diagram





5.3.11. Deep Power-Down(B9H)

Executing the Deep Power-Down (DP) command is the only way to put the device in the lowest power consumption mode (the Deep Power-Down Mode). It can also be used as an extra software protection mechanism, since in this mode, the device ignores all Write, Program and Erase commands. Driving CS# high deselects the device, and puts the device in the Standby Mode (if there is no internal cycle currently in progress). But the Standby Mode is different from the Deep Power-Down Mode. The Deep Power-Down Mode can only be entered by executing the Deep Power-Down (DP) command. Once the flash memory has entered the Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down and Read Device ID command (ABH) and software reset (66H+99H). This command releases the flash memory from the Deep Power-Down Mode.

The Deep Power-Down Mode automatically stops at Power-Off, and the device always Power-Up in the Standby Mode. The Deep Power-Down (DP) command is entered by driving CS# low, followed by the command code on SI, driving CS# high.

The Deep Power-Down command sequence: CS# goes low→sending Deep Power-Down command→CS# goes high. The command sequence is shown in Figure 32. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Deep Power-Down (DP) command will not be executed. As soon as CS# is driven high, it requires a time duration of tDP before the supply current is reduced to ICC2 and the Deep Power-Down Mode is entered. Any input of Deep Power-Down (DP) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

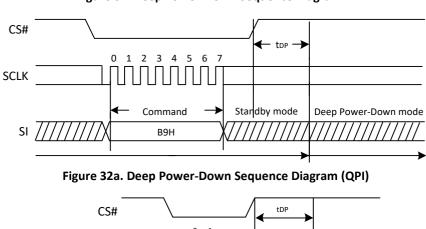
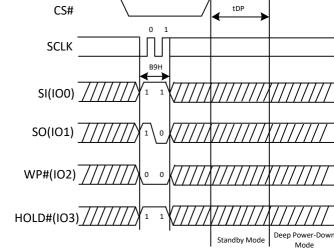


Figure 32. Deep Power-Down Sequence Diagram





5.3.12. Release From Deep Power-Down(ABH)

The Release from Deep Power-Down and Read Device ID command is a multi-purpose command. It can be used to release the device from Deep Power-Down Mode or obtain the devices electronic identification (ID) number.

To release the device from Deep Power-Down Mode, the command is issued by driving the CS# pin low, shifting the instruction code "ABH" and driving CS# high as shown in Figure 33. Release from Deep Power-Down Mode will take the time duration of tRES1 (See AC Characteristics) before the device resume to normal state and other command are accepted. The CS# pin must remain high during the tRES1 time duration.

When the command is used only to obtain the Device ID while the flash memory is not in Deep Power-Down Mode, the command is initiated by driving the CS# pin low and shifting the instruction code "ABH" followed by 3-dummy byte. The Device ID bits are then shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure 33b. The Device ID value is listed in Manufacturer and Device Identification table. The Device ID can be read continuously. The command is completed by driving CS# high.

When the command is used to release the device from Deep Power-Down Mode and obtain the Device ID, the command is the same as previously described, and shown in Figure 33b. , except that after CS# is driven high it must remain high for a time duration of tRES2 (See AC Characteristics). After this time duration the device will resume to normal mode and other command will be accepted. If the Release from Deep Power-Down and Read Device ID command is issued while an Erase, Program or Write cycle is in process (when WIP equal 1) the command will be ignored and will not affect the current cycle.

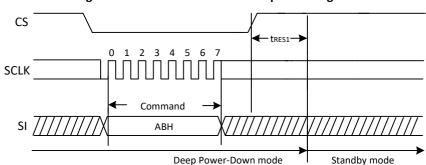
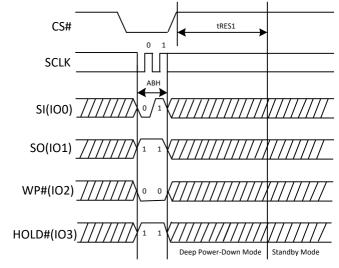
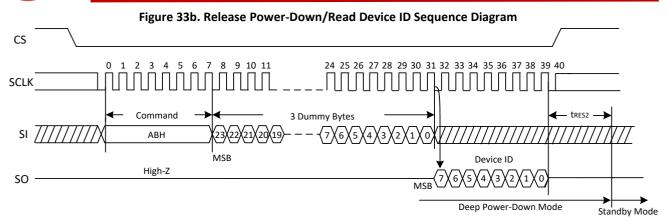


Figure 33. Release Power-Down Sequence Diagram









Release From Deep Power-Down/Read Device ID (ABH) in QPI mode

The Release From Deep Power-Down/Read Device ID command is also supported in QPI mode. See the figure below, In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.

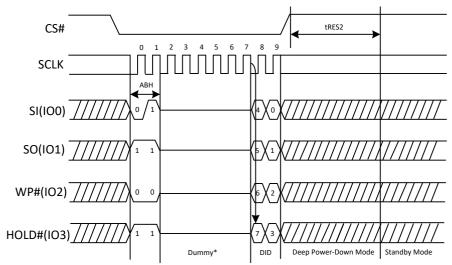


Figure 33c. Release Power-Down/Read Device ID Sequence Diagram (QPI)

*Set Read Parameters Command (COH) can set the number of dummy cycles

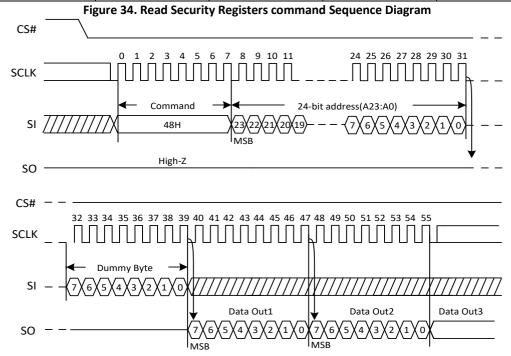


5.4. One-Time Programmable (OTP) Operations

5.4.1. Read Security Register(48H)

The Read Security Registers command is similar to Fast Read command. The command is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency fC, during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next address after each byte of data is shifted out. Once the A9-A0 address reaches the last byte of the register (Byte 3FFH), it will reset to 000H, the command is completed by driving CS# high.

| Address | A23-A16 | A15-A12 | A11-A10 | A9-A0 |
|-----------------------|----------|---------|---------|--------------|
| Security Registers #1 | 00000000 | 0001b | 00b | Byte Address |
| Security Registers #2 | 00000000 | 0010b | 00b | Byte Address |
| Security Registers #3 | 00000000 | 0011b | 00b | Byte Address |



Note: The Byte Address A2-A0 must be 000.



Read Security Register (48H) in QPI mode

The Read Security Register command is also supported in QPI mode. See the figure below, In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (COH)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8.

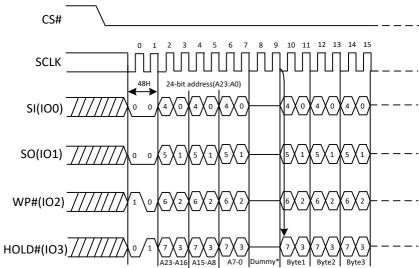


Figure 34a. Read Security Registers command Sequence Diagram (QPI)

*Set Read Parameters Command (COH) can set the number of dummy cycles



5.4.2. Program Security Register(42H)

42H

The Program Security Registers command is similar to the Page Program command. It allows from 1 to 1024 bytes Security Registers data to be programmed. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Program Security Registers command. The Program Security Registers command is entered by driving CS# Low, followed by the command code (42H), three address bytes and at least one data byte on SI. As soon as CS# is driven high, the self-timed Program Security Registers cycle (whose duration is tPP) is initiated. While the Program Security Registers cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Program Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

If the Security Registers Lock Bit (LB1, LB2, LB3) is set to 1, the corresponding Security Registers (#1, #2, #3) will be permanently locked. Program Security Registers command will be ignored.

| · · · · · · · · · · · · · · · · · · · | <u> </u> | 0 | | |
|---------------------------------------|----------|---------|---------|--------------|
| Address | A23-A16 | A15-A12 | A11-A10 | A9-A0 |
| Security Registers #1 | 00000000 | 0001b | 00b | Byte Address |
| Security Registers #2 | 0000000 | 0010b | 00b | Byte Address |
| Security Registers #3 | 00000000 | 0011b | 00b | Byte Address |

Security Registers #3 00000000 0011b 00b Byte Address

Figure 35. Program Security Registers command Sequence Diagram

CS#

SCLK

Command

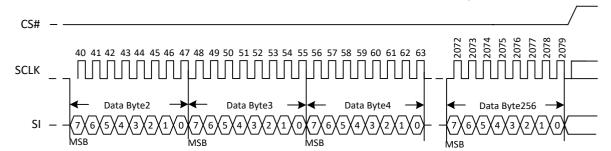
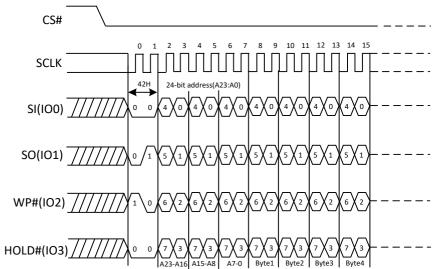


Figure 35a. Program Security Registers command Sequence Diagram (QPI)





5.4.3. Erase Security Register(44H)

The device provides 3x1024-byte Security Registers which only erased each 1024-byte at once. These registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Registers command is similar to Sector/Block Erase command. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit.

The Erase Security Registers command sequence: CS# goes low -> sending Erase Security Registers Command -> CS# goes high. The command sequence is shown in Figure 36. CS# must be driven high after the eighth bit of the command code has been latched in, otherwise the Erase Security Registers command is not executed. As soon as CS# is driven high, the self-timed Erase Security Registers cycle (whose duration is tSE) is initiated. While the Erase Security Registers cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Erase Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Security Registers Lock Bit (LB1, LB2, LB3) in the Status Register can be used to OTP protect the security registers. Once the LB bit is set to 1, the corresponding Security Registers (#1, #2, #3) will be permanently locked; the Erase Security Registers command will be ignored.

| Address | A23-A16 | A15-A12 | A11-A10 | A9-A0 |
|-----------------------|----------|---------|---------|------------|
| Security Registers #1 | 00000000 | 0001b | 00b | Don't Care |
| Security Registers #2 | 00000000 | 0010b | 00b | Don't Care |
| Security Registers #3 | 00000000 | 0011b | 00b | Don't Care |

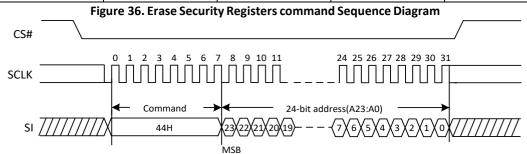
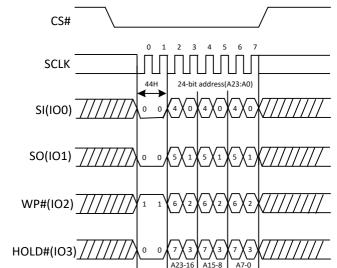


Figure 36a. Erase Security Registers command Sequence Diagram





5.5. Advanced Data Protection

5.5.1. Global Block/Sector Lock (7EH) or Unlock (98H)

All Block/Sector Lock bits can be set to 1 by the Global Block/Sector Lock command, or can set to 0 by the Global Block/Sector Unlock command.

The Global Block/Sector Lock command (7EH) sequence: CS# goes low -> SI: Sending Global Block/Sector Lock command -> CS# goes high. The command sequence is shown in Figure 37.

The Global Block/Sector Unlock command (98H) sequence: CS# goes low -> SI: Sending Global Block/Sector Unlock command -> CS# goes high. The command sequence is shown in Figure 37b.

Figure 37. The Global Block/Sector Lock Sequence Diagram

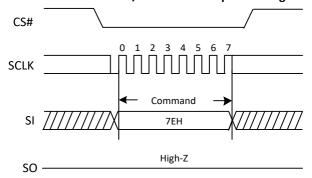


Figure 37a. The Global Block/Sector Lock Sequence Diagram (QPI)

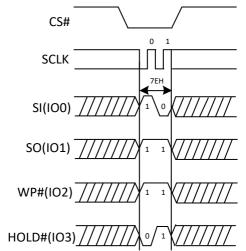




Figure 37b. The Global Block/Sector Unlock Sequence Diagram

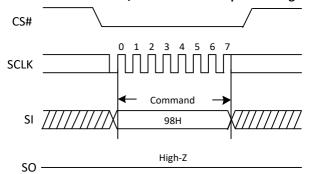
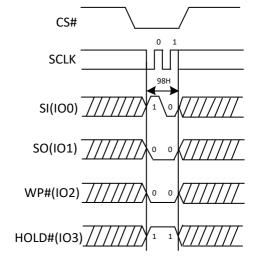


Figure 37c. The Global Block/Sector Unlock Sequence Diagram (QPI)





5.5.2. Individual Block/Sector Lock (36H) / Unlock (39H) / Read (3DH)

The individual block/sector lock provides an alternative way to protect the memory array from adverse Erase/Program. In order to use the Individual Block/Sector Locks, the WPS bit in Status Register must be set to 1. If WPS=0, the write protection will be determined by the combination of CMP, BP (4:0) bits in the Status Register. The Individual Block/Sector Lock bits are volatile bits, the default values of which after device power up or after a Reset are 1.

The individual Block/Sector Lock command (36H) sequence: CS# goes low -> SI: Sending individual Block/Sector Lock command -> SI: Sending 24bits individual Block/Sector Lock Address -> CS# goes high. The command sequence is shown in Figure 38.

The individual Block/Sector Unlock command (39H) sequence: CS# goes low -> SI: Sending individual Block/Sector Unlock command -> SI: Sending 24bits individual Block/Sector Lock Address -> CS# goes high. The command sequence is shown in Figure 38a.

The Read individual Block/Sector lock command (3DH) sequence: CS# goes low -> SI: Sending Read individual Block/Sector Lock command -> SI: Sending 24bits individual Block/Sector Lock Address -> SO: The Block/Sector Lock Bit will out -> CS# goes high. If the least significant bit(LSB) is1, the corresponding block/sector is locked, if the LSB is 0, the corresponding block/sector is unlocked, Erase/Program operation can be performed. The command sequence is shown in Figure 38c.

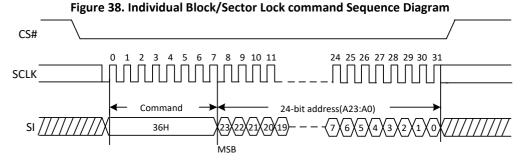
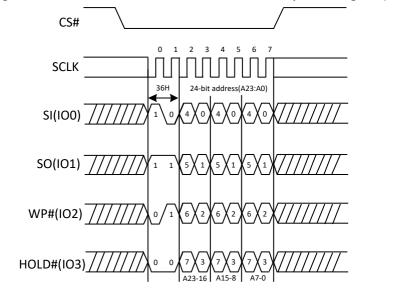
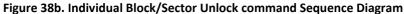


Figure 38a. Individual Block/Sector Lock command Sequence Diagram (QPI)







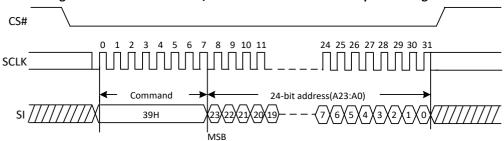


Figure 38c. Individual Block/Sector Unlock command Sequence Diagram (QPI)

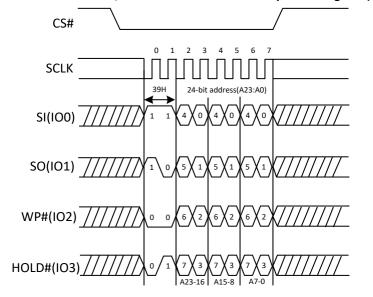


Figure 38d. Read Individual Block/Sector lock command Sequence Diagram

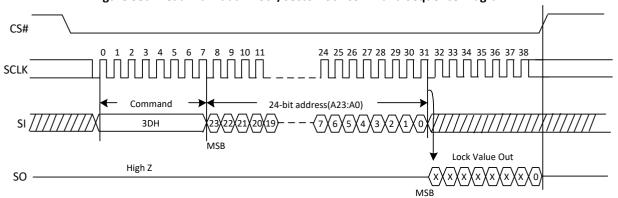
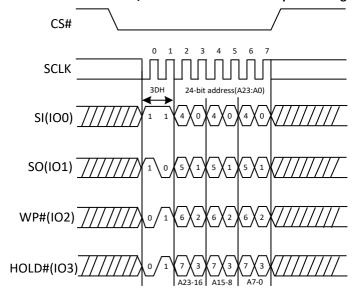




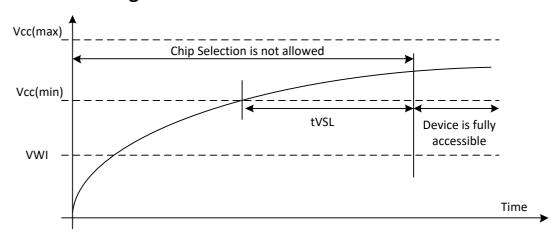
Figure 38e. Read Individual Block/Sector lock command Sequence Diagram (QPI)





6. ELECTRICAL CHARACTERISTICS

6.1. Power-on Timing



Power-Up Timing and Write Inhibit Threshold

| Symbol | Parameter | Min | Max | Unit |
|------------------|-----------------------|-----|-----|------|
| t _{VSL} | VCC(min) To CS# Low | 200 | | us |
| V _{wI} | Write Inhibit Voltage | - | 1.5 | V |

6.2. Initial Delivery State

The device is delivered with the memory array erased: all bits are set to 1(each byte contains FFH). All Status Register bits except S22 bits are 0, S22 bit is 1.



6.3. Absolute Maximum Ratings

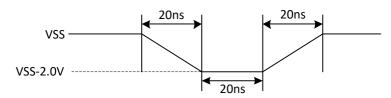
| Parameter | Value | Unit |
|-------------------------------|-------------|------------|
| Ambient Operating Temperature | -40 to 85 | $^{\circ}$ |
| Storage Temperature | -65 to 150 | $^{\circ}$ |
| Output Short Circuit Current | 200 | mA |
| Applied Input/Output Voltage | -0.5 to 4.0 | V |
| VCC | -0.5 to 4.0 | V |

6.4. Capacitance Measurement Condition

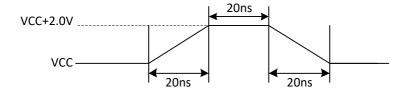
| Symbol | Parameter | Min | Тур | Max | Unit | Conditions |
|--------|---------------------------------|------------------|--------|-----|------|------------|
| CIN | Input Capacitance | | | 6 | pF | VIN=0V |
| COUT | Output Capacitance | | | 8 | pF | VOUT=0V |
| CL | Load Capacitance | 30 | | pF | | |
| | Input Rise And Fall time | | | 5 | ns | |
| | Input Pulse Voltage | 0.1VCC to 0.8VCC | | V | | |
| | Input Timing Reference Voltage | 0.2VCC to 0.7VCC | | V | | |
| | Output Timing Reference Voltage | | 0.5VCC | | V | |

Input Test Waveform and Measurement Level

Maximum Negative Overshoot Waveform



Maximum Positive Overshoot Waveform





6.5. DC Characteristics

(T=-40°C~85°C,VCC=1.65~2.0V)

| Symbol | Parameter | Test Condition | Min. | Тур | Max. | Unit |
|------------------------------|--|--|---------|-----|---------|------|
| ILI | Input Leakage Current | | | | ±2 | μΑ |
| ILO | Output Leakage Current | | | | ±2 | μΑ |
| ICC1 | Standby Current | CS#=VCC VIN=VCC or VSS | | 12 | 30 | μА |
| ICC2 | Deep Power-Down Current | CS#=VCC VIN=VCC or VSS | | 0.4 | 8 | μА |
| ICC3 Operating Current(Read) | CLK=0.1VCC/0.9VCC at 133MHz, Q=Open(*1,*2 | | 13 | 16 | mA | |
| | I/O) CLK=0.1VCC/0.9VCC at 80MHz, Q=Open(*1,*2 I/O) | | 6 | 10 | mA | |
| | | CLK=0.1VCC/0.9VCC at 133MHz, Q=Open(*4 I/O) | | 16 | 20 | mA |
| | | CLK=0.1VCC/0.9VCC at 80MHz, Q=Open(*4 I/O) | | 10 | 16 | mA |
| ICC4 | Operating Current(PP) | CS#=VCC | | | 20 | mA |
| ICC5 | Operating Current(WRSR) | CS#=VCC | | | 20 | mA |
| ICC6 | Operating Current(SE, BE, CE) | CS#=VCC | | | 20 | mA |
| VIL | Input Low Voltage | | -0.5 | | 0.2VCC | V |
| VIH | Input High Voltage | | 0.7VCC | | VCC+0.4 | V |
| VOL | Output Low Voltage | IOL=1.6mA | | | 0.4 | V |
| VOH | Output High Voltage | IOH=-100uA | VCC-0.2 | | | V |

Note:

- 1. Typical values given for TA=25°C.
- 2. Value guaranteed by design and/or characterization, not 100% tested in production.



6.6. AC Characteristics

(T=-40°C~85°C,VCC=1.65~2.0V, CL=30pF)

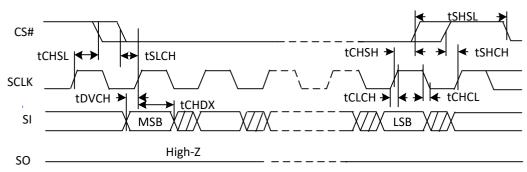
| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|---------------------|--|-------|------|------|------|
| fC1 | Serial Clock Frequency For: all command except for 03H, EBH, BBH, EDH under SPI mode | D.C. | | 133 | MHz |
| fC2 | Serial Clock Frequency For: EBH, BBH and QPI instructions | D.C. | | 108 | MHz |
| fC3 | Clock frequency DTR instructions EDH | D.C. | | 96 | MHz |
| fR | Serial Clock Frequency For: Read (03H) | D.C. | | 80 | MHz |
| tCLH ⁽¹⁾ | Serial Clock High Time | 45%PC | | | ns |
| tCLL ⁽¹⁾ | Serial Clock Low Time | 45%PC | | | ns |
| tCLCH | Serial Clock Rise Time(Slew Rate) | 0.2 | | | V/ns |
| tCHCL | Serial Clock Fall Time(Slew Rate) | 0.2 | | | V/ns |
| tSLCH | CS# Active Setup Time | 5 | | | ns |
| tCHSH | CS# Active Hold Time | 5 | | | ns |
| tSHCH | CS# Not Active Setup Time | 5 | | | ns |
| tCHSL | CS# Not Active Hold Time | 5 | | | ns |
| tSHSL | CS# High Time (read/write) | 20 | | | ns |
| tSHQZ | Output Disable Time | | | 8 | ns |
| tCLQV | Clock Low To Output Valid | | | 5 | ns |
| tCLQX | Output Hold Time | 1 | | | ns |
| tDVCH | Data In Setup Time | 2 | | | ns |
| tCHDX | Data In Hold Time | 2 | | | ns |
| tHLCH | Hold# Low Setup Time(relative to Clock) | 5 | | | ns |
| tHHCH | Hold# High Setup Time(relative to Clock) | 5 | | | ns |
| tCHHL | Hold# High Hold Time(relative to Clock) | 5 | | | ns |
| tCHHH | Hold# Low Hold Time(relative to Clock) | 5 | | | ns |
| tHLQZ | Hold# Low To High-Z Output | | | 6 | ns |
| tHHQX | Hold# High To Low-Z Output | | | 6 | ns |
| tWHSL | Write Protect Setup Time Before CS# Low | 20 | | | ns |
| tSHWL | Write Protect Hold Time After CS# High | 100 | | | ns |
| tDP | CS# High To Deep Power-Down Mode | | | 3 | us |
| tRES1 | CS# High To Standby Mode Without Electronic Signature Read | | | 6 | us |
| tRES2 | CS# High To Standby Mode With Electronic Signature Read | | | 3 | us |
| tRST | CS# High To Next Command After Reset | | | 20 | us |
| tSUS | CS# High To Next Command After Suspend | | | 20 | us |
| tRS | Latency Between Resume And Next Suspend | 100 | | | us |
| tW | Write Status Register Cycle Time | | 1 | 20 | ms |
| tPP | Page Programming Time | | 0.4 | 1 | ms |
| tSE | Sector Erase Time | | 40 | 300 | ms |
| tBE1 | Block Erase Time (32K Bytes) | | 0.12 | 1 | S |
| | , | | | - | |

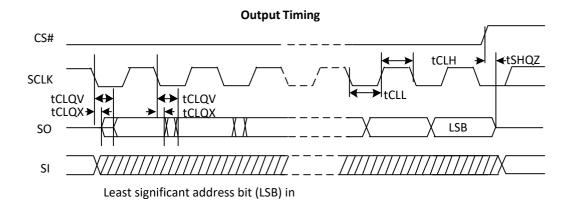
| tBE2 | Block Erase Time (64K Bytes) | 0.15 | 1.2 | S |
|------|------------------------------|------|-----|---|
| tCE | Chip Erase Time | 20 | 50 | S |

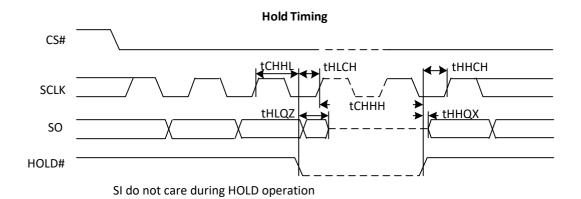
Note:

- 1. Clock high or Clock low must be more than or equal to 45%PC. PC=1/fC(MAX).
- 2. Typical values given for TA=25°C. Value guaranteed by design and/or characterization, not 100% tested in production.

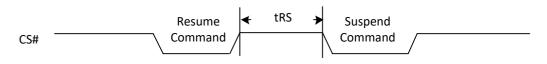
Serial Input Timing







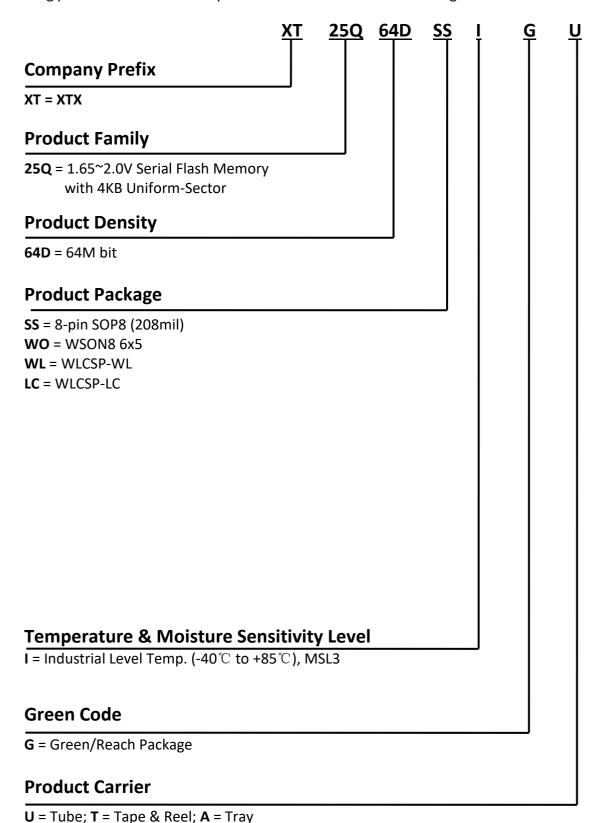
Resume to Suspend Timing Diagram





7. ORDERING INFORMATION

The ordering part number is formed by a valid combination of the following

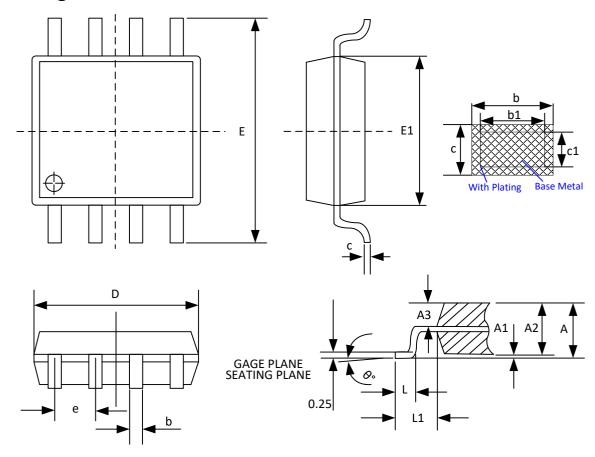


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8. PACKAGE INFORMATION

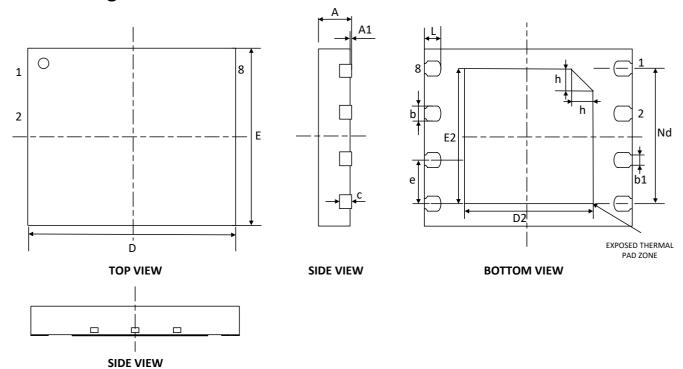
8.1. Package SOP8 208mil



| SYMBOL | MILLIMETER | | | | |
|-----------|------------|------|------|--|--|
| STIVIBUL | MIN | NOM | MAX | | |
| Α | 1.75 | 1.95 | 2.15 | | |
| A1 | 0.05 | 0.15 | 0.25 | | |
| A2 | 1.70 | 1.80 | 1.90 | | |
| А3 | 0.75 | 0.80 | 0.85 | | |
| b | 0.33 | _ | 0.51 | | |
| b1 | 0.30 | _ | 0.48 | | |
| С | 0.17 | _ | 0.25 | | |
| c1 | 0.15 | 0.20 | 0.23 | | |
| D | 5.13 | 5.23 | 5.33 | | |
| E | 7.70 | 7.90 | 8.10 | | |
| E1 | 5.18 | 5.28 | 5.38 | | |
| е | 1.27 BSC | | | | |
| L | 0.50 | 0.65 | 0.80 | | |
| L1 | 1.31 REF | | | | |
| θ | 0° | _ | 8° | | |



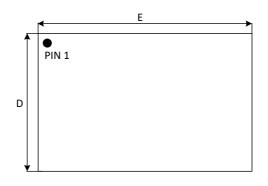
8.2. Package WSON8 6x5mm

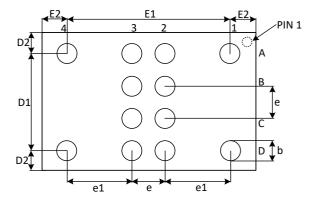


| SYMBOL | MILLIMETER | | | | |
|----------|------------|-------------|------|--|--|
| STIVIBUL | MIN | NOM | MAX | | |
| Α | 0.70 | 0.75 | 0.80 | | |
| A1 | 0.00 | 0.02 | 0.05 | | |
| b | 0.35 | 0.40 | 0.45 | | |
| b1 | 0.25 REF | | | | |
| С | 0.18 0.20 | | 0.25 | | |
| D | 5.90 | 6.00 | 6.10 | | |
| Nd | 3.81 BSC | | | | |
| e | 1.27 BSC | | | | |
| E | 4.90 | 5.00 5.10 | | | |
| D2 | 3.30 | 0 3.40 3.50 | | | |
| E2 | 3.90 | 4.00 | 4.10 | | |
| L | 0.55 | 0.60 | 0.65 | | |
| h | 0.30 | 0.35 | 0.40 | | |

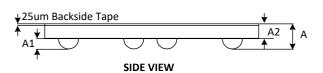


8.3. Package WLCSP-WL





TOP VIEW

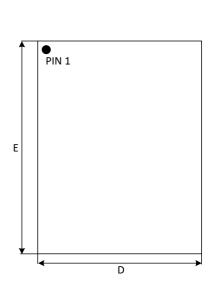


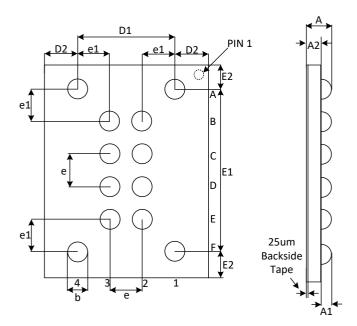
BOTTOM VIEW

| | nbol nit | А | A1 | A2 | D1 | E1 | e | e1 | b |
|----|-------------|-------|-------|-------|--------------|--------------|--------------|--------------|-------|
| | Min | 0.430 | 0.140 | 0.290 | 4.500 | 2.400 | 0.500 | 0.000 | 0.270 |
| mm | Тур | 0.480 | 0.165 | 0.315 | 1.500 BSC | 2.100 BSC | 0.500 BSC | 0.800 BSC | 0.300 |
| | Max | 0.530 | 0.190 | 0.340 | DSC | BSC | DSC | BSC | 0.330 |



8.4. Package WLCSP-LC





TOP VIEW BOTTOM VIEW SIDE VIEW

| | mbol Init | Α | A1 | A2 | D1 | E1 | e | e1 | b |
|----|--------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | Min | 0.430 | 0.140 | 0.290 | 4 000 | | | | 0.270 |
| mm | Тур | 0.480 | 0.165 | 0.315 | 1.300 | 2.300 | 0.500 | 0.400 | 0.300 |
| | Max | 0.530 | 0.190 | 0.340 | BSC | BSC | BSC | BSC | 0.330 |



9. REVISION HISTORY

| Revision | Description | Date |
|----------|---|-------------|
| 1.0 | Initial version | Dec-8-2020 |
| 1.1 | Added CE operation current -> 20mA max Revise unit for tRST Deleted Latch up Characteristics, refer to Qualification Report. Adjust command COH's description to add P2 Updated SFDP table Operating Voltage range 1.65~2.1V -> 1.65~2.0V | Mar-23-2021 |
| 1.2 | Update POD of SOP8 208mil, WSON8 6x5mm and WLCSP-LC | Mar-29-2021 |
| 1.3 | Correct pin name on WLCSP-LC connection diagram Changed 3EH in SFDP Table and update SFDP Table | Apr-23-2021 |